Mobile Communications

MPI™

403-512 MHZ
PERSONAL RADIO
2/4 WATTS

Maintenance Manual

TABLE OF CONTENTS

COMBINATION NOMENCLATURE

DIGITS 1&2	DIGIT 3	DIGIT 4	DIGIT 5	DIGIT 6	DIGIT 7	DIGIT 8	DIGIT 9
Product Code	Package	TX Frequency Range	RX Frequency Range	Channel Spacing	RF Power Output	Max. Channel Capacity	Control
P5 MPI	**C** Local/ Remote	**M** 403-425 MHz	**M** 403-425 MHz	**5** 25 KHz	**5** 1.7-3.8 Watts	**B** 2 Tx-2 Rx	**E** Standard
		N 420-450 MHz	**N** 420-450 MHz		**6** 3.9-6.4 Watts	**C** 2 Tx-1 Rx	
		R 450-470 MHz	**R** 450-470 MHz			**D** 1 Tx-2 Rx	
		S 470-494 MHz	**M** 470-494 MHz				
		T 489-512 MHz	**T** 489-512 MHz				

RC5121

STRUCTURED OPTIONS

A Option TX Xtals	**B** Option RX Xtals	**C** Option	**D** Option	**E** Option	**F** Option	**H** Option	**K** Alt IF
A 1 Xtal	**A** 1 Xtal	**O** None	**O** None	**O** None	**O** None	**O** None	**O** None
B 2 Xtals	**B** 2 Xtals	**2** 1 Tone Enc CG	**L** T-99 Ind.	**I** DTMF	**4** Int. Safe	**A** CGE UHF	**3** Alt IF
O No Xtals	**O** No Xtals	**U** 1 Tone/Enc DCG	**M** T-99 Ind.-Group			**B** CGE HB	
		4 1 Code Enc. DCG.	**N** T-99 Ind. CG Enc				
		D 1 Code Enc/ Dcc DCG					
		R 1 Tone CG Enc w/Switch					
		S 1 Tone DCG Enc w/Switch					

RC4345A Sheet 2

TYPICAL SPECIFICATIONS*

SYSTEM

FCC IDENTIFICATION NUMBER	
2-WATT	AXA9MZTR102A-450-512 MHz
4-WATT	AXA9MZTR121A-450-470 MHz AXA9MZTR121B-470-494 MHz AXA9MZTR121C-489-512 MHz
FREQUENCY RANGE	403-512 MHz
BATTERY DRAIN (MAXIMUM)	
Receiver	
Standby	15 milliamperes
Rated Audio	150 milliamperes
Transmitter	800 milliamperes @ 7.5 Volts (2-Watt) 1250 milliamperes @ 10 Volts (4-Watt) 7.81 on 4-Watt
TEMPERATURE RANGE	-30°C (-22°F) to +60°C (140°F)
DIMENSIONS (EIA) LESS ACCESSORIES (H X W X D)	7.11 x 2.59 x 1.46 inches (180.5 x 65.7 x 37.1 millimeters)
WEIGHT, WITH ANTENNA	2-Watt 455 grams (16 ounces) 4-Watt 492 grams (17.3 ounces)

BATTERY LIFE

	2-Watt	4-Watt
At 5% - 5% - 90% Duty Cycle	8 hours	6.5 hours
At 2% - 8% - 90% Duty Cycle	12 hours	11 hours

TRANSMITTER

POWER OUTPUT	2 Watts/4 Watts
FREQUENCY STABILITY	0.0005%
CONDUCTED SPURIOUS AND HARMONIC EMISSION	-16 dBm
RATED SYSTEM DEVIATION	±5 kHz
FM HUM & NOISE	Greater than 50 dB
AUDIO FREQUENCY CHARACTERISTICS FCC and EIA.	Frequency Response per EIA RS 316-B. Post limiter filter per
DISTORTION	Less than 5% (300 to 3000 Hz)
DEVIATION SYMMETRY	1.0 kHz maximum

	NO DEGRADATION	1 dB DEGRADATION	3 dB DEGRADATION
MAXIMUM FREQUENCY SPREAD	7 MHz	9 MHz	10 MHz
RF OUTPUT IMPEDANCE	50 ohms		

RECEIVER

AUDIO OUTPUT (to 8.0 ohm speaker)	500 milliwatts (less than 5% distortion)
SENSITIVITY	
12 dB SINAD	0.35 uV
20 dB Quieting	0.50 uV
FREQUENCY STABILITY	0.0005%
SELECTIVITY EIA Two-Signal Method	-70 dB @ ±25 kHz
SPURIOUS RESPONSE	-60 dB
INTERMODULATION	-65 dB
MODULATION ACCEPTANCE	±6.7 kHz
SQUELCH SENSITIVITY	<6 dB SINAD
FREQUENCY RESPONSE	EIA RS 316-B

	NO DEGRADATION	3 dB DEGRADATION	6 dB DEGRADATION
MAXIMUM FREQUENCY SPREAD	2 MHz	4 MHz	6 MHz
RF INPUT IMPEDANCE	50 ohms		

* These specifications are intended primarily for use of the serviceman. Refer to the appropriate Specifications Sheet for the complete specifications.

DESCRIPTION

General Electric MPI Personal radios are extremely compact, high performance two-way FM radios designed for operation in the 403-512 MHz range. The lightweight radio utilizes both discrete components and Integrated Circuit modules (IC's).

All operating controls except the Push-To-Talk (PTT) switch and frequency select switch are conveniently located on the top of the radio. The frequency select and PTT switches are located on the side of the radio. An earphone jack, located above the PTT switch, is used with an earphone to provide message privacy, or to permit the operator to receive messages in noisy locations.

An external microphone jack is located next to the earphone jack. This permits the transmitter to be keyed and messages transmitted using the external microphone.

Power for the radio is supplied by a rechargeable nickel-cadmium battery pack that fits in the bottom front section of the case. The battery pack can be recharged either in or out of the radio.

Test Adaptor 4EX12A12 is available to provide audio connections for servicing the transmitter and receiver.

OPERATION

If the radio is equipped with an option switch, disable the option before adjusting the radio by placing the switch in the OFF or MONITOR position. After adjusting the radio, place the option switch back in the CG OR T99 position (See Figure 1).

ADJUSTING THE RADIO

To Receive a Message:

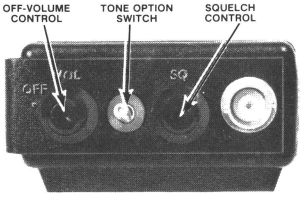
1. Turn the OFF-VOLUME control about half way to the right.
2. Disable any option by placing the option control toggle switch (if present) in the OFF or MONITOR POSITION.
3. Turn the SQUELCH (SQ) control to the right as far as possible. A hissing sound will be heard from the speaker.
4. Adjust the VOLUME control until the hissing sound is easily heard but not annoyingly loud.
5. Turn the SQUELCH control slowly to the left until the hissing noise just stops. This adjustment is very important as it eliminates annoying noise when no one is calling you. It also determines how sensitive your radio will be to incoming calls.
6. In two-frequency units, select the proper frequency. You are now ready to receive messages from other radios in your system.

To Send a Message:

1. Turn on the radio as directed in the "To Receive a Message" section.
2. In two-frequency units, select the proper frequency. Then listen to make sure that no one is using the channel.
3. Hold the radio so that the antenna is vertical. Then, press the Push-To-Talk (PTT) bar and speak directly into the microphone in a clear and distinctive voice. Always release the PTT bar as soon as you stop talking. You cannot receive messages while the PTT bar is pressed.

CHARGERS

Three battery chargers are available for recharging the Nickel-Cadmium battery pack. For specific instructions, refer to the applicable operating instruction or maintenance manual.



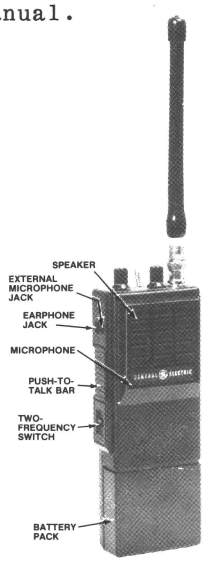
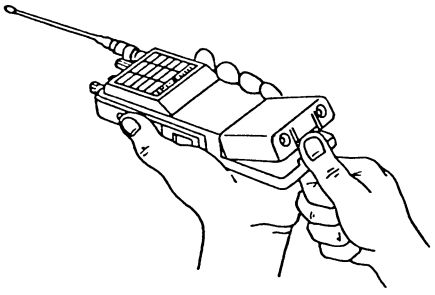


Figure 1 - Operating Controls

BATTERY PACK REPLACEMENT

To remove the battery pack from the radio:

1. Turn the radio OFF.
2. Place thumb on bottom of battery pack and press battery pack to-ward the top of radio as shown.
3. Then push bottom of battery pack away from the radio.



WARNING

Do not dispose of battery packs or batteries by burning. To do so may cause an explosion.

OSCILLATOR CRYSTAL REPLACEMENT

Crystals Y1, Y2, Y4, and Y5 are plug-in types for ease of replacement. Note that one lead is grounded to the crystal can. This lead must be plugged into the socket which is connected to the ground plane of the Transmit/Receive Board.

CIRCUIT ANALYSIS

TRANSMITTER

The Transmitter is a crystal-controlled, frequency modulated transmitter for one- or two-frequency operation in the 403-512 MHz bands. The transmitter utilizes discrete components to provide a minimum RF power output of two watts. The transmitter consists of the following assemblies.

- Audio Board - with the microphone amplifier/limiter, post-limiter filter and oscillator compensator circuits.
- Transmit/Receive (TR) Board - Oscillator, Multiplier stages, amplifier, driver and PA stages, TR switch, and low-pass filter.

All supply voltages for the transmitter are provided by the battery and the Regulator. The different transmitter voltages required are shown in the following chart:

Voltage	Used For
Continuous 10/7.5 Volts	Post-limiter filter, driver and PA circuits
Switched TX 10/7.5 Volts	Multipliers, 1st amplifier, and driver base voltage
Switched TX 5.4 Volts	Mic amp/limiter, microphone and oscillator
Regulated 5.4 Volts	Compensator and modulator circuits

References to symbol numbers mentioned in the following text are found on the Schematic Diagrams, Outline Diagrams and Parts List. A block diagram of the complete transmitter and receiver is shown in Figure 2.

AUDIO CIRCUITS

Audio from the microphone is applied to a 6 dB pre-emphasis network (R16, D1, C15 and C18) and then to amplifier-limiters Q3 and Q4. The output of Q4 is applied to the post-limiter filter consisting of Q6, Q7, Q8 and associated circuitry.

The output of the post-limiter filter is coupled through C30 and the modulation circuitry to transmitter oscillator Q15.

A compensator circuit (Q9 and R36 through R40) provides frequency compensation at low temperatures for the transmitter and receiver oscillators.

T/R BOARD

OSCILLATOR

The temperature compensating DC voltage and audio is applied to FM modulators D6 and D7 through MOD ADJ controls R67 and R73. The modulator varactor varies the transmit frequency at the audio rate applied from the audio board.

Q15, Y4, Y5 and associated circuitry comprise a Colpitts oscillator. The transmit oscillator is adjusted to the assigned operating frequency by L39 and L42. The oscillator output is applied to buffer Q14. Channel 1 or Channel 2 is selected by S2.

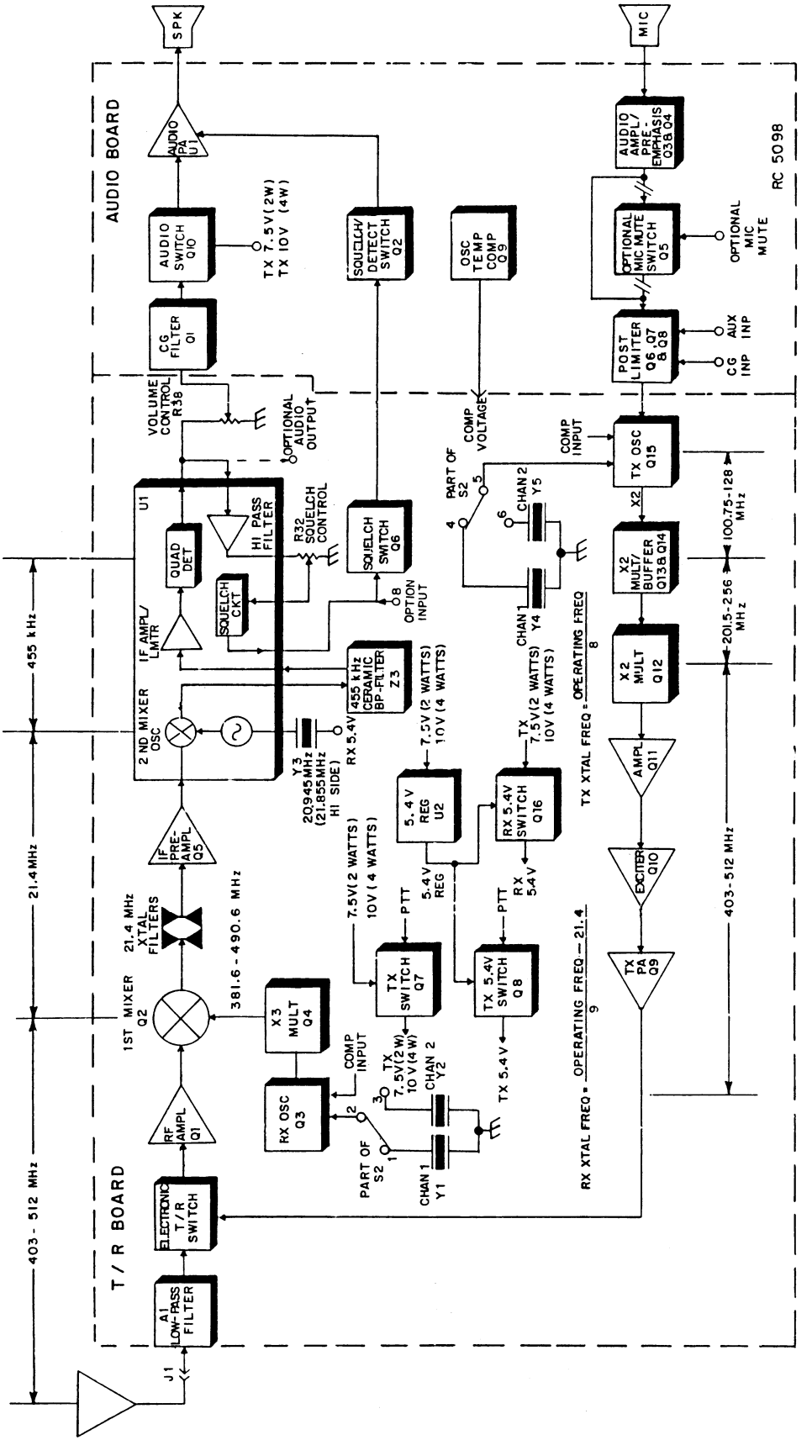


Figure 2 - Block Diagram

L37 in the collector circuit of Q15 is tuned to the second harmonic. L36 provides additional filtering before multiplier/buffer stages Q13 and Q14. Drive to the multiplier/buffer stages can be monitored at J10 (TP4).

MULTIPLIERS

The output of Q13 is tuned to the fourth harmonic by L34 and L35, and applied to the base of multiplier Q12.

The output of multiplier Q12 is tuned to the eighth harmonic by C78 and C81. The emitter voltage of Q12 can be monitored at J9 (TP5).

AMPLIFIERS AND PA

Following Q12 is Class B amplifier Q11. Emitter voltage can be monitored at J8 (TP6). The output of Q11 is tuned by C70 to provide maximum drive to Q10. The output of Q10 is applied to the base of PA transistor Q9. C63 is tuned to provide impedance matching to the PA stage.

A collector feed network consisting of L19, L20, L24, L25, C57, C61, C66, C68, R44 and R47 acts as a stablizing and decoupling network for Q9 and Q10.

Power adjust control C56 is used to set the output power at two watts. The PA output is applied to the antenna switch.

ANTENNA SWITCH

The solid state antenna switch consists of A1-D1, C1, C2, L1 and D1 on the TR board. The circuit acts as a 1/4-wave line simulator.

Keying the transmitter applies approximately 1.6 volts to the anode of A1-D1, forward biasing the diode. When A1-D1 is forward biased, the 1/4-wave line appears as an open circuit to the RF output of the transmitter. This allows the transmitter output to be coupled through the low-pass filter to the antenna. L17, C102 and R43 provide bias and decoupling for the antenna switch.

The antenna switch acts as a 50-ohm line in the receiver mode (A1-D1 not forward biased).

RECEIVER

The receiver is a dual conversion, superheterodyne FM receiver designed for one or two-frequency operation in the 403-512 MHz frequency range. A regulated 5.4 volts is used for all receiver stages except for the audio PA IC, receiver RF amplifier and mixer which operate from the 7.5 volt battery.

The receiver has intermediate frequencies of 21.4 MHz and 455 kHz. Adjacent channel selectivity is obtained by using three band-pass filters: (2) 21.4 MHz two-pole crystal filters and a 455 kHz ceramic filter.

All of the receiver circuitry except the audio PA and oscillator compensator is mounted on the transmitter/receiver (TR) board. The receiver consists of:

- Receiver Front End
- 21.4 MHz 1st IF circuitry
- 1st and 2nd Oscillators
- 455 kHz 2nd IF circuitry with FM Detector
- Audio PA Circuitry
- Squelch Circuitry

RECEIVER FRONT END

An RF signal from the antenna is coupled through the low-pass filter, antenna switch, and image filter to the emitter of RF amplifier Q1. The image filter consists of C3, C4, C5, C108 and L2.

The output of Q1 is coupled through two tuned circuits that provide most of the front end selectivity. The tuned circuits are L3, R4, C8 and C9, L4 and L5.

OSCILLATOR AND MULTIPLIER

Q3, Y1, D2 and associated circuitry make up a Colpitts oscillator. The frequency is controlled by a third mode crystal operated at one ninth of the required injection frequency. Voltage-variable capacitor D2, L48 and Y1 are connected in series to provide compensation capability. The compensation voltage used to control the transmitter oscillators is applied to D2 to maintain stability. L48 is adjustable to set the oscillator frequency. R8 is in parallel with Y1 to insure operation on the third overtone of the crystal.

The oscillator output is coupled through two tuned circuits (L12-C25 and L13) to the base of tripler Q4. C25 and L13 are tuned to the third harmonic of the oscillator frequency. The output of tripler Q4 is coupled to the gate of first mixer Q2 through two tuned circuits (L14 and L15). L14 and L15 are tuned to

the operating frequency minus 21.4 MHz which is the ninth multiple of the crystal frequency.

The DC level of the oscillator can be monitored at J6 (TP1). The meter reading at this point is typically 5.2 volts. The DC level of tripler Q4 can be measured at J7 (TP2). This meter reading is typically 5.2 volts.

1ST MIXER AND IF FILTER

The 1st mixer uses a FET (Q2) as the active device. The FET mixer provides a high input impedance, high power gain and an output relatively free of intermodulation products).

In the mixer RF from the front end filter is applied to the gate of the mixer. Injection voltage from the multiplier stages is also applied to the gate of the mixer. The 21.4 MHz mixer 1st IF output signal is coupled from the drain of Q2 to crystal filters Z1 and Z2. Tuneable capacitor C12 is used to match the mixer output to the input of Z1.

The highly-selective crystal filter provides the first portion of the receiver IF selectivity. The output of the filter is coupled through R20 to the 1st IF amplifier.

Supply voltage for the RF amplifier and 1st mixer can be metered at J5 (TP3). The meter reading is typically 7.4 volts.

1ST AND 2ND IF AND DETECTOR STAGES

The 21.4 MHz IF output of the crystal filters is applied to the base of IF amplifier Q5. The amplifier provides approximately 12 dB of IF gain. The output of Q5 is coupled through C35 to the input of the 2nd Mixer IC.

U1A and associated circuitry consists of the 2nd oscillator and mixer. The crystal for the oscillator is Y3. The oscillator operates at 20.945 MHz for low side injection of the 2nd IF (standard), or 21.855 MHz for high side injection for those radios determined to be operating on a tweet frequency. This frequency is mixed with the 21.4 MHz input to provide the 455 kHz 2nd IF frequency.

The output of U1A is coupled through ceramic filter Z3 which provides the 455 kHz selectivity. The filter output is applied to U1B.

U1B and associated circuitry consists of an IF amplifier, 455 kHz limiter and a quadrature type FM detector. L10 is the quadrature detector coil. Volume control R38 is used to set the audio output level to the audio amplifier. R37 and C48 provide a low pass filter to remove 455 kHz from the audio.

AUDIO AND SQUELCH CIRCUITS

Audio

Audio from the VOLUME arm is coupled through a twin-T Channel Guard notch filter that consists of Q1 and associated circuitry. The filter attenuates any audio frequency below 211 Hz.

The audio output from the filter is coupled through receiver muting switch Q10 to audio amplifier U1. Q10 is turned on in the receive mode to pass the audio. The 500 milliwatt audio output of U1 is coupled through C10 to the speaker and earphone jack.

A 6 dB/octave de-emphasis is provided by C12, C6 and R10 in the audio feedback path. R7 and C5 provide additional de-emphasis at higher frequencies.

Squelch

The squelch circuit operates on the noise components contained in the FM detector output. The output of U1B is applied to a high-pass filter consisting of U1C, and associated circuitry. The output of U1C is noise in a band around 8 kHz.

With no RF signal present, the noise is rectified by D4 and a negative voltage is applied to the input of U1D, keeping it turned off and the receiver muted.

Pressing the PTT switch also forward biases clamping diode D5, keeping U1D input bias at the correct standby voltage in the transmit mode.

RECEIVER SWITCH

Releasing the PTT switch turns off the transmitter switches and turns on receiver switch Q16. This applies 5.4 volts to the receiver oscillators, IF amplifier, audio and squelch stages.

When an RF signal is received (receiver unsquelches), no noise is rectified by D4 and the input voltage at pin 12 of U1D rises to approximately +1 volt. This positive voltage turns on U1D, causing the output at U1D-14 to go positive, turning on buffer Q6. When turned on, the collector voltage of Q6 goes low, turning on PNP audio board squelch switch Q2. Turning on Q2 applies 7.5 volts to audio amplifier U1. This turns on U1 so that audio is heard at the speaker.

VOLTAGE REGULATOR AND TR SWITCHES

Turning on-off switch to the "on" position applies 7.5 volts to voltage regulator hybrid, U2. The hybrid provides a continuous, regulated 5.4-Volt output at U2-2.

TRANSMITTER SWITCHES

Pressing the PTT switch turns on Q7 and Q8. When Q7 is turned on, 7.5 volts from the battery is applied to the transmitter multipliers and 1st amplifier stages. The 7.5 volts is also applied to the gate of receiver muting FET Q10. The positive voltage on the gate turns Q10 off and mutes the receiver in the transmit mode. The switched 7.5 volts is also applied to the base of RX 5.4 volt switch Q16, turning the switch off in the transmit mode.

DISASSEMBLY

To remove the front cover for servicing, first remove the battery. Then remove the two screws at A and lift off the front cover (See Figure 3).

To gain access to the back of the TR board, remove the two screws at A and the screw at B and remove the front and back covers.

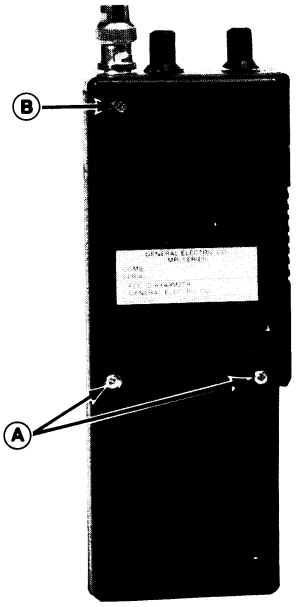


Figure 3 - Disassembly

CAUTION

Due to the excellent "drive" capability of the miniature TORX®-head screws, it is relatively easy to overtorque and damage the screws. The torque required for the screws is as follows:

1. **4 inch-pounds for the three M2.5 screws in the back cover.**
2. **2 1/4 inch-pounds for the three M2 screws holding the accessory area cover plate (under the battery).**

DO NOT OVERTORQUE!

If the radio is equipped with an option board, in addition to the above steps, the three screws holding the option cover must be removed.

NOTE

The option board must be slightly raised to clear the option cover mounting boss before removing the back cover.

CAUTION

Do not bend the thin option board material any more than necessary.

ERICSSON

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REPLACING CHIP COMPONENTS

Replacement of chip capacitors should always be done with a temperature-controlled soldering iron, using a controlled temperature of 700°F (371°C). However, do NOT touch black metal flim of the resistors or the ceramic body of capacitors with the soldering iron.

NOTE

The metalized end terminations of the parts may be touched with the soldering iron without causing damage.

REMOVING CHIP COMPONENTS

1. Grip the component with tweezers or needle nose pliers.
2. Alternately heat each end of the chip in rapid succession until solder flows, and then remove and discard the chip.
3. Remove excess solder with a vacuum solder extractor or Solder-wick®.
4. Carefully remove the epoxy adhesive and excess flux to prevent damage to the printed board.

REPLACING CHIP COMPONENTS

1. Using as little solder as possible, "tin" one end of the component and one of the pads on the printed wiring board.
2. Place the "tinned" end of the component on the "tinned" pad on the board and simultaneously touch the component and the pad with a well "tinned" soldering iron while pressing the component down on the board.
3. Place the "tinned" soldering iron on the other end of the component and the pad simultaneously. Apply solder to the top of the end of the component until the solder starts to flow. Use as little solder as possible while getting a good joint.
4. After the component has cooled, remove all flux from the component and printed wiring board area with alcohol.

HOLE CHART

HOLE	DESCRIPTION
1	PTT SWITCH GND
2	OPT. GND
3	OPT. SW. GND
4	OPT. 10V[+7.5V]*
5	PTT FROM OPT.
6	OPT. +5.4V REG.
7	DISCRIMINATOR OUTPUT
8	OPT. MUTE
9	PTT OUTPUT TO OPTIONS
10	PTT SWITCH (HOT)
11	CG TONE INPUT TO XMTR
12	FROM OPT. TO OPT. SW. CONN.
13	FROM OPT. SW. TO OPT. CONN.
14	PTT OUTPUT FROM OPTIONS
15	SQUELCH FROM OPTIONS
16	TX 10V[+7.5V]*
0	
18	JUMPER WIRE
19	
20	GND. FOR RF CHOKE
21	OPTION SW GND FOR MIN LO VOL OPTION

TEST POINT CHART

TP	FUNCTION	TYPICAL V
1	RX Injection Tuning	5.2
2	Rx Injection Tuning	5.2
3	RX Injection Tuning	9.9V[7.4V]
4	TX Drive Tuning	0.4
5	TX Drive Tuning	0.6
6	TX Drive Tuning	0.8
7	Battery Input	10V[7.5V]
8	Ground	0

* [] = Voltages in brackets are for 2-Watt Transmitters

SERVICE TOOLS

4EX12A12 - Personal Radio Test Set (Does not include any interconnect cables)

19B234242G1 - Internal J4 Interconnect Cable (May be used with any MPI radio)

19B234242G2 - External Audio Jacks Interconnect Cable (Only used on units with remote mic capability)

Option 4120 - (Replaced TS 10 Service Tool Kit)
- ST 2513 - Coil and Trim Pot Alignment Tool
- ST 2521 - Oscillator Coil Alignment Tool
- ST 2519 - Johanson Capacitor Alignment Tool (0.029" tip)
- ST 2520 - Johanson Capacitor Alignment Tool (0.025" tip)
- 19A702672P1 - Battery Test Lead (Black)
- 19A702672P2 - Battery Test Lead (Red)
- 19B800747P3 - Audio Board Jumper Cable. Tin Contacts. (2 Required)
- 19B801406P57 - Audio Board Jumper Cable. Gold Contacts. (2 Cables Required)
- 19A144745G1 - Receiver Audio Test Cable
- 19B800968G1 - RF Probe Assembly

19D900773G1 - 7.5 Volt Dummy Battery Pack

19D900773G2 - 10 Volt Dummy Battery Pack

Mechanical Tools:
- ST 2307 - Spanner wrench for audio jacks
- ST 2311 - Spanner wrench for volume & squelch controls
- ST 0720 - Hex driver & assortment of 9 TORX bits

SYMPTOM	PROCEDURE
No 10V[7.5V] Supply	Check power connections and continuity of supply leads, and check fuse. If fuse is blown, check radio for shorts.
Low 10V[7.5V] Supply	Check for low or uncharged battery possibly with bad cell.
No 5.4V Regulated Supply	Check the 10V[7.5V] supply at pin 3 of regulator Q2. If a large standby current (i.e., >100 mA) is seen, check for a short to ground on the 5.4V output line.
No Rx	Check the 5.4V regulated supply. Then check 5.4V switching transistor Q15.
No Audio Output	Check audio board squelching transistor, Q2. If the audio amplifier U1 is properly biased on, inject a 50 mV RMS, 1 kHz signal into the preceding stages until the faulty stage is isolated as follows. This signal must be capacitively coupled from the audio generator using a 1 uF electrolytic capacitor to avoid shifting bias voltages. Sequentially inject signal into the following points on the audio bc_rd: Pin 3 of U1, emitter of Q1, base of Q1, and P2-5 (volume control dependent). If the problem is not found on the audio board, check for recovered audio on the main board with an oscilloscope. Recovered audio should be seen at Pin 9 of U1, at Hole 7, and at Pin 3 of R40 (as well as the wiper depending upon position).
Low Audio	Measure supply voltage at Pin 6 of audio board IC (U1) and gate voltage of Q10. Verify that at least 150 mV (424 peak-to-peak) is present at Hole 7 when a strong RF signal is applied to the radio with standard test modulation. Check quad coil (L16) setting.
Distorted Audio Output	Apply a strong RF signal with standard test modulation and measure audio distortion into an 8 ohm dummy load (e.g., test adaptor box). Distortion should be less than 5% at 2 volts output at 1 kHz. If there is low electrical distortion and acoustical distortion is still present, listen with test box or swap front covers with another radio to test speaker.
No or Incorrect Detector Output	Verify bias to Pins 4 and 8 of the main board IC, U1. Using a 50 ohm probe, inject a strong 10.7 MHz modulated signal into Pin 16 of U1. Recovered audio should be seen at Pin 9 and the level should vary with the setting of quad coil, L16. If none is seen, check the second oscillator for activity. At least 80 mV of RF should be seen on Pin 1 to ground.
No 2nd Oscillator Activity	Substitute a known good crystal for Y3. Check voltages on U1 pins 1 and 2.
Radio Permanently Squelched	Verify that main board IC, U1, is properly biased at Pins 4 and 8 and that quad coil L16 is correctly adjusted. The voltage at the Schmidt trigger input (U1 Pin 12) should rise and fall with the setting of R34. The output at pin 14 should switch bias on and off to the base of Q6 as the input threshold is crossed. The collector of Q6 should saturate and unsquelch the radio once the input (Pin 12) is above the threshold, approx. 0.8V.
Radio Won't Squelch	Verify that main board IC, U1, is properly biased at Pins 4 and 8 and that quad coil L16 is correctly adjusted. An oscilloscope should see high frequency (approx. 8 kHz) noise at the noise filter output, U1 pin 11. This noise should be seen at the wiper of R34 (dependent upon position) and should be negatively rectified by D4. The remainder of the squelch circuit is described under the "Radio Permanently Squelched" section.

SYMPTOM	PROCEDURE
Poor or No Sensitivity	Verify that proper injection power is present and at the correct frequency, (f & -10.7). This can be done by 50 ohm probe across L40. The power seen should be approximately 0 dBm. If OK, then use the 50 ohm probe with a signal generator to inject signal into various portions of the radio to isolate the bad section. Set the generator with standard modulation to the level and frequency indicated on the large service schematic and probe those points starting with the IC (U1) and moving forward to the antenna jack. In some cases parts must be adjusted for best sensitivity while probing. This is indicated on the schematic. Once the faulty stage is isolated, measure bias voltages.
No or Low Injection Power	Verify that tuning procedure has been done or tried. The oscillator string can be trouble shot by using a 50 ohm probe connected to a power meter capable of measuring power as low as -20 dBm. Probe the available power points to ground indicated on the large service schematic. The power seen should be approximately that shown on the schematic. Any adjustment needed during probing is indicated on the schematic. Start probing with the oscillator and proceed towards the mixer. Bias voltages are also shown on the schematic for both a running and non-running oscillator. To kill a running oscillator, place a .01 uF ceramic capacitor with short leads from the base to collector of the oscillator transistor Q3.
Receive Frequency Won't Adjust Properly	Check compensator voltage at P3-2 and at varicap (D2 or D9). Check anode voltage of varicap.
No Transmit 5.4V	Check the switching transistor Q14.
Radio Won't Go Into Transmit Mode	Verify that Hole 9 is going to ground when the PTT switch is pushed. If Channel Guard is present, first short Hole 9 and then Hole 5 to ground. Both operations should cause the radio to go into transmit mode unless a problem exists with the Channel Guard circuitry.
Low or No Transmit Power	Check battery voltage when in transmit. Low or uncharged battery or shorted cell will be <7 volts If the total transmit current is >500 mA, check the low pass filter and T/R switch. 1.6 VDC at C91 indicates that the radio is in the transmit mode. If the total transmit current is <100 mA, measure the base bias of Q13. Check for proper test point readings at TP4, TP5, TP6.
High TP6	0.2 - 0.4 VDC indicates proper drive into Q11. 0.6 VDC indicates no drive. Check the bias voltages.
Low TP5	0.7 - 0.9 VDC indicates proper drive into Q12. 0.5 VDC indicates no drive. Check the bias voltages.
High TP4	0.3 - 0.5 VDC indicates proper drive from the oscillator. With no oscillator activity TP4 will be 0.7 VDC.
Transmit Frequency Will Not Adjust Properly	Check the compensator voltage at P3-2. Check the anode voltage of the varicaps (D6 or D7).
No Transmitter Deviation	Disconnect the front cover and connect the test box. Apply 600 mV to TX audio. Check the DC and Audio Voltages on the Audio Board as indicated on the service schematic during transmit. If values are as indicated, substitute another front cover to test the microphone.

TRANSMITTER ALIGNMENT

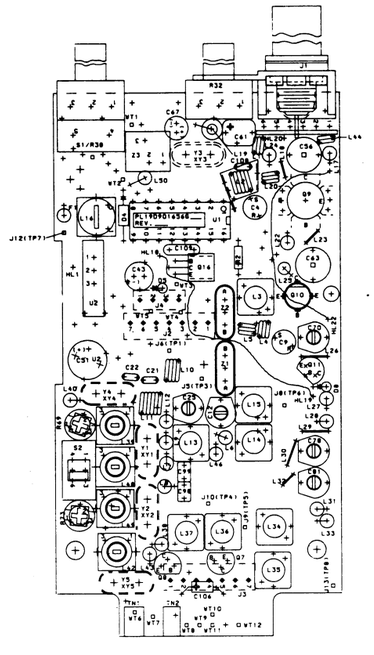
EQUIPMENT REQUIRED

1. Power Supply (10 Volts, 2 Ampere).
2. 50 ohm Wattmeter with 50 ohm load
3. Audio Oscillator
4. Deviation Monitor
5. Frequency Counter
6. Digital Voltmeter
7. Tune-up Kit Option 4120 (contains coil tuning tools, capacitor tuning tools, dummy battery, audio board jumper cables, and a 50 ohm probe).
8. Test adaptor 4EX12A12 and cable 19B234242G1 (Option 2847).

PRELIMINARY STEPS AND ADJUSTMENTS

1. In addition to the antenna mounting bracket screw, the radio must be held tight against the back cover at the lower right corner near the negative battery terminal (e.g. use a 4-40 screw and nut).
2. Unplug the audio board and front cover from the main board.
3. Insert the dummy battery into the battery pack area and apply nominal battery voltage (7.5 or 10 Volts as required) to the RED terminal (BLACK terminal is ground) on dummy battery pack.
4. Pre-set the tuning slugs in L39 (and L42 in two-frequency radios) to the center of their tuning range. Next, set the slugs in coils L34 through L37 flush with the top of the coil form. Then set the arrows on the rotors of C70, C78 and C81 pointing to the rounded end of the capacitor.
5. All adjustments are made with the transmitter keyed and Channel Guard enabled, if present.

> **NOTE**
>
> In two-frequency radios, switch to the highest frequency.



(19D901658, Rev. 5)

ALIGNMENT PROCEDURE

STEP	METERING POINT	TUNING CONTROL	PROCEDURE
1.	TP4	L37 and L36	Adjust L37 and L36 in that order for a dip in meter reading. Repeat if necessary.
2.	TP5	L34 and L35	Adjust L34 and L35 in that order for a peak in meter reading. Repeat if necessary.
3.	TP6	C81 and C78	Adjust C81 and C78 in that order for a peak meter reading. Repeat if necessary.
4.	Wattmeter	C70, C63 C56	Adjust C70, C63 and C56 in that order for maximum power output.
5.	Wattmeter	C56	Turn C56 in the direction that causes both the power and current to decrease, and adjust C56 for an output of 2.2 Watts or 4.4 watts as applicable. **NOTE** If the radio draws more than rated current, spread the turns on L44 and re-adjust C56 for maximum power output. Then repeat Step 5.
		FREQUENCY ADJUSTMENT	
6.	Frequency Counter	L39 and L42	Plug the audio board onto the main board. In single frequency radios, adjust L39 for the proper frequency. In two frequency radios, switch to Channel 1 and adjust L39 for the proper frequency. Then switch to Channel 2 and adjust L42 for the proper frequency.
		MODULATION ADJUSTMENT	
7.	Deviation Monitor	R69 and R73	Connect the test adaptor with cable to J4 and switch to channel 1. Apply 600 millivolts at 1 kHz to the test adaptor and adjust R69 for 4.5 kHz deviation with Channel Guard enabled, if present. In two-frequency radios, switch to channel 2 and adjust R73 for 4.5 kHz deviation with Channel Guard enabled, if present.

RECEIVER ALIGNMENT

EQUIPMENT REQUIRED

1. 10-Volt Power Supply. (0.5 amps)
2. Floating terminal (non-grounded) multimeter with at least 3 1/2 digits and a 200 millivolt DC lowest range.
3. RF generator.
4. Distortion analyzer.
5. MPI Tune-up kit Option 4120 containing coil tuning tools, trimmer capacitor tuning tools, dummy battery, audio board jumper cables and a 50 ohm probe.
6. Test Adaptor 4EX12A12 and MPI Cable 19B234242G1 (Option 2849 for internal jack, or Option 4990 for jacks on side rail.

PRELIMINARY CHECKS AND ADJUSTMENTS

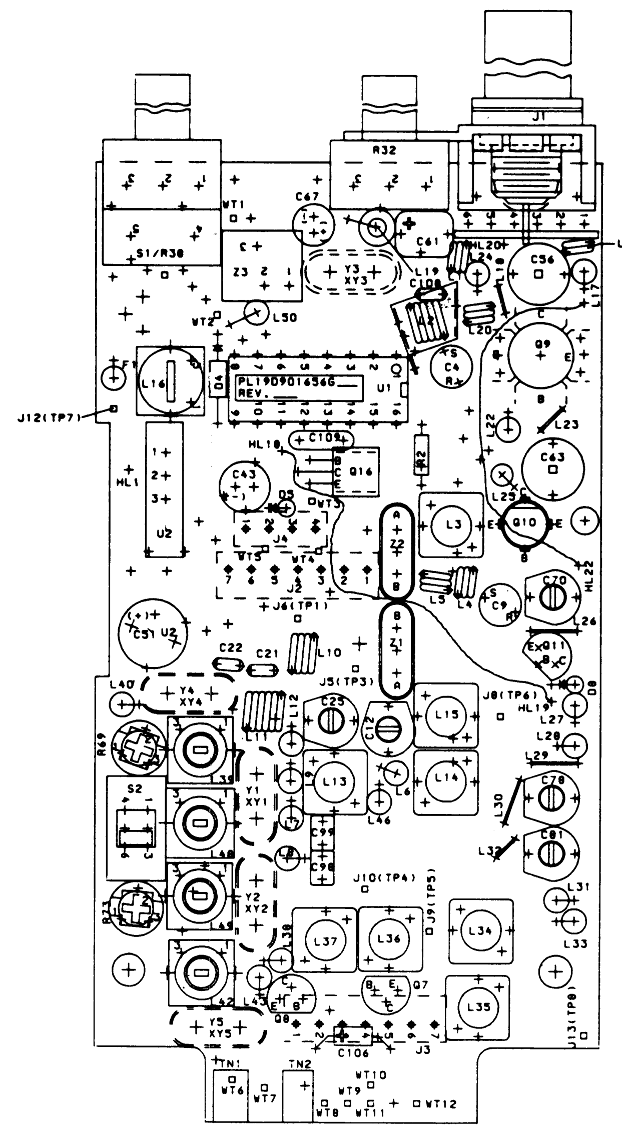
1. In addition to the antenna mounting bracket screw, the radio must be held tight against the back cover at the lower right corner near the negative battery terminal or TP8 (e.g. use a 4-40 screw and nut).
2. Remove the front cover and unplug the Audio board from the main board. Then connect the audio board to the main board with the jumper cables.
3. Insert the dummy battery into the battery pack area and apply nominal supply voltage (7.5 or 10 Volts as required). Volts to the RED terminal (BLACK terminal is ground) on dummy battery.
4. Pre-set the tuning slugs in L3, L13, L14, L15, L48 and L49 to the top of the coil form. Then set the arrow on the rotor of C12 and C25 so that it points towards the rounded end of the capacitor.
5. Disable Channel Guard, if present.

NOTE

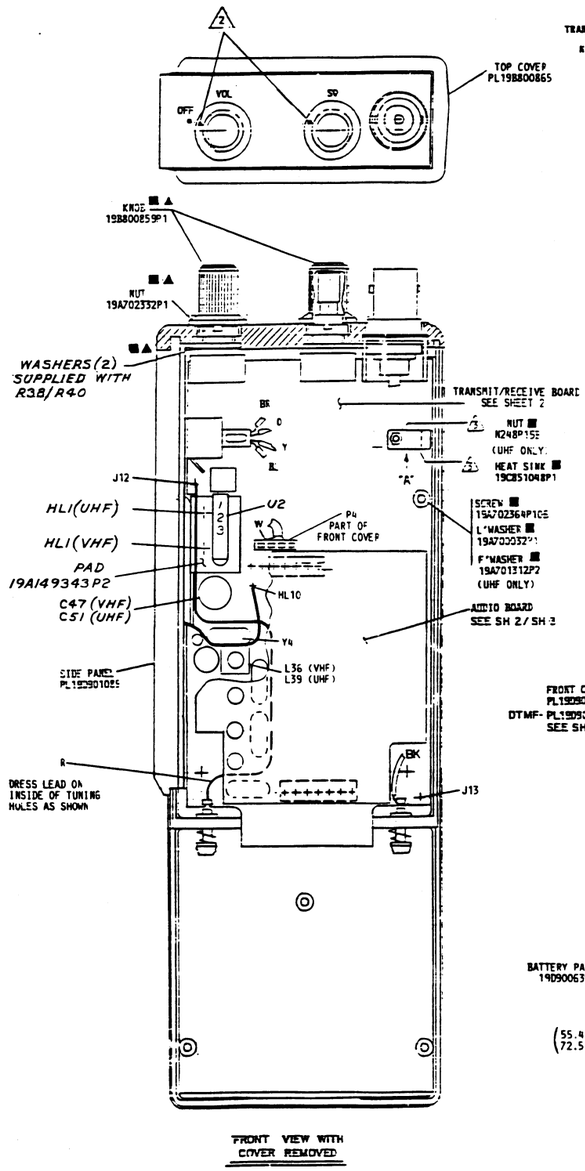
In two-frequency radios, all adjustments are made on the lowest frequency except as directed.

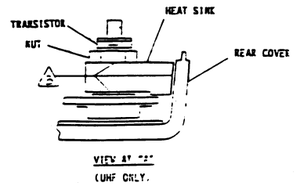
ALIGNMENT PROCEDURE

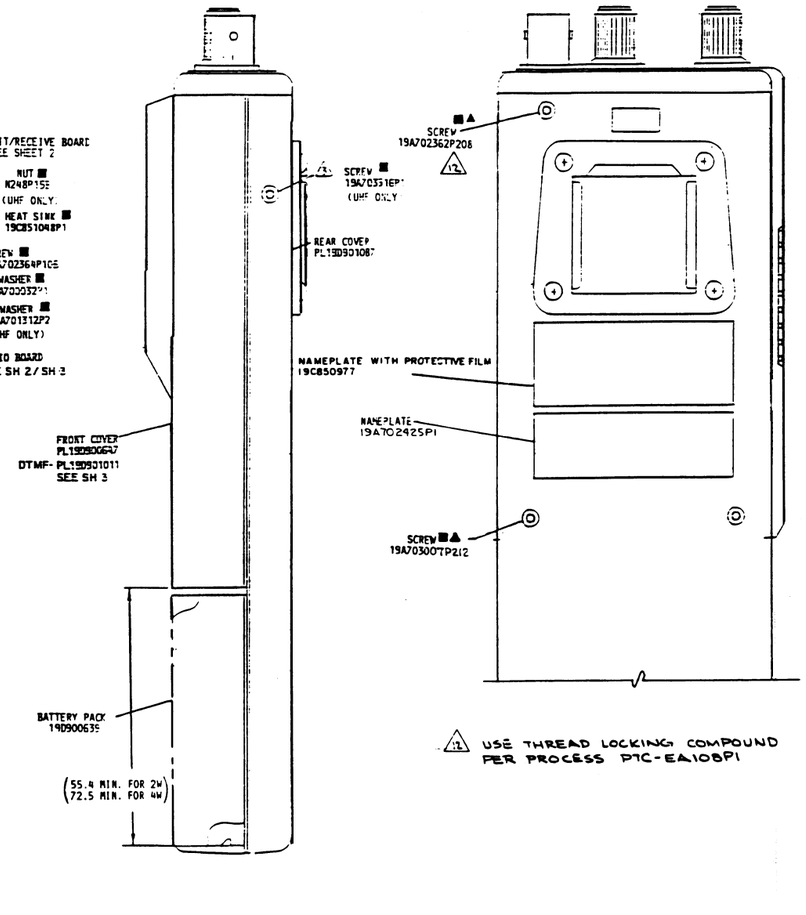
STEP	METERING POINT	TUNING CONTROL	PROCEDURE
1.	Audio Output Jack (J1 on side panel)	L16	Set the Volume Control an audio level of approximately 1 Volt RMS to keep out of limiting. Using the 50 ohm probe, apply a strong modulated 21.4 MHz signal (>-50 dBm) to U1A-16 on T/R board and adjust L16 for maximum audio output. **NOTE:** If a 21.4 MHz generator is not available, adjust L16 for maximum noise.
2.	J2-7 and TP1	L48 (Chan 1) or L49 (Chan 2)	For two frequency radios, select the lowest frequency. While measuring between J2-7 (regulator voltage) and TP1, adjust L48 or L49 for maximum meter reading (approximately 250 millivolts).
3.	Audio Output Jack (J1 on side panel)	C25, C9 and L13	Apply a strong (0 dBm) signal to the antenna jack. Adjust C25, C9 and L13 for best quieting. C25 will have more than two dips, so use only the stronger one. Then adjust C25 and L13 again for best quieting.
4.	Audio Output Jack (J1 on side panel)	L14, L15, C4, L3 and C9	Adjust L14, L15, C4, L3 and C9 in that order for best quieting. **NOTE:** If L15 does not tune properly (multiple dips, no dips, etc.), set the arrow on C12 towards the flat end of the capacitor.
5.	Distortion Analyzer	L48, L49 and C12	Add 1 kHz tone modulation at 5 kHz deviation to the carrier. Leave the Volume control as in Step 1. Alternately adjust lowest frequency warp coil (L48 or L49) and C12 until no improvement in SINAD is seen. This will insure that the match to the crystal filters is properly adjusted, and that the carrier is centered in the pass band (zero beating isn't required). On 2 frequency radios switch to the other channel and adjust the other warp coil (L48 or L49) for best SINAD.
6.	Distortion Analyzer	C4	On two-frequency radios, switch to the lowest frequency. Set the signal generator to the image frequency (42.8 MHz below the carrier frequency) and increase the RF level to approximately -60 dBm. Then adjust C4 for the amount of image rejection desired by degrading the quieting on SINAD. Then reset the signal generator to 3 kHz before doing any standard measurements.



(19D901658, Rev. 5)







CONNECTION CHART	
FROM	TO
SIDE PANEL-BK	TRANSMIT/RECEIVE BD-HL1 (1)
SIDE PANEL-Y	TRANSMIT/RECEIVE BD-J1 (1) (2)
REAR COVER	TRANSMIT/RECEIVE BD-J2
REAR COVER	TRANSMIT/RECEIVE BD-J3
SIDE PANEL-BL	TRANSMIT/RECEIVE BD-HL24 UHF/HL21 VHF
SIDE PANEL-Y	TRANSMIT/RECEIVE BD-J5 UHF/HL22 VHF
SIDE PANEL-Y	TRANSMIT/RECEIVE BD-J5 UHF/HL22 VHF
SIDE PANEL-BL	TRANSMIT/RECEIVE BD-J7 UHF/HL25 VHF

(1) VHF
SEE NOTES 4 5 8

(2) UHF
SEE NOTE 8

(3) VHF - TWO FREQ TX & SINGLE FREQ RX
SEE NOTES 4 6

(4) UHF - TWO FREQ TX & SINGLE FREQ RX
SEE NOTE 6

(5) DTMF
SEE SH. #3

(6) VHF - SINGLE FREQ TX & TWO FREQ RX
SEE NOTES 4 7

(7) UHF - SINGLE FREQ TX & TWO FREQ RX
SEE NOTE 7

NOTES:

1. ITEMS MARKED ■ ARE PART OF HARDWARE KIT PL19A702379G2 (UHF).
   ITEMS MARKED ▲ ARE PART OF HARDWARE KIT PL19A702379G3 (VHF).

2. ROTATE OFF/ON-VOL POT TO EXTREME COUNTER CLOCKWISE (OFF) POSITION. ASSEMBLE KNOB WITH INDICATOR MARK ALIGNED WITH MARK ON TOP COVER. ROTATE SQUELCH POT TO EXTREME COUNTER CLOCKWISE POSITION. ASSEMBLE KNOB WITH INDICATOR MARK IN APPROXIMATELY SAME POSITION AS THE OFF/ON-VOL KNOB.

3. APPLY SILICON GREASE (19A701337P1 PER 19A701431 BETWEEN MATING SURFACES OF HEAT SINK, NUT, TRANSISTOR AND REAR COVER. SCREW MUST BE TIGHTENED BEFORE NUT. NUT TIGHTENING TORQUE TO BE .3 N-M.

4. a. CUT RUN ON SOLDER SIDE OF TX/RX BOARD 19D901660G1 WHEN LOWEST TX FREQ. SPECIFIED IS BELOW 142 MHZ OR ON TX/RX BOARD 19D901660G2 WHEN LOWEST TX FREQ. SPECIFIED IS BELOW 162 MHZ AS SHOWN IN DETAIL "G" (SH. #2).
   b. CUT RUN ON SOLDER SIDE OF TX/RX BOARD 19D901660G2 WHEN HIGHEST RX FREQ. SPECIFIED IS BELOW 162 MHZ AS SHOWN IN DETAIL "G" (SH. #2)

5. a. WHEN NO TX CRYSTALS ARE SPECIFIED ON PRODUCTION TAG DO NOT CUT RUN SHOWN IN DETAIL "G" (SH. #2) PER NOTE N.A.
   b. WHEN NO RX CRYSTALS ARE SPECIFIED ON PRODUCTION TAG DO NOT CUT RUN SHOWN IN DETAIL "G" (SH. #2) PER NOTE N.B.

6. CUT RUN ON SOLDER SIDE OF TX/RX BOARD AND ADD JUMPERS AS SHOWN IN DETAIL "D" (SH. #2).

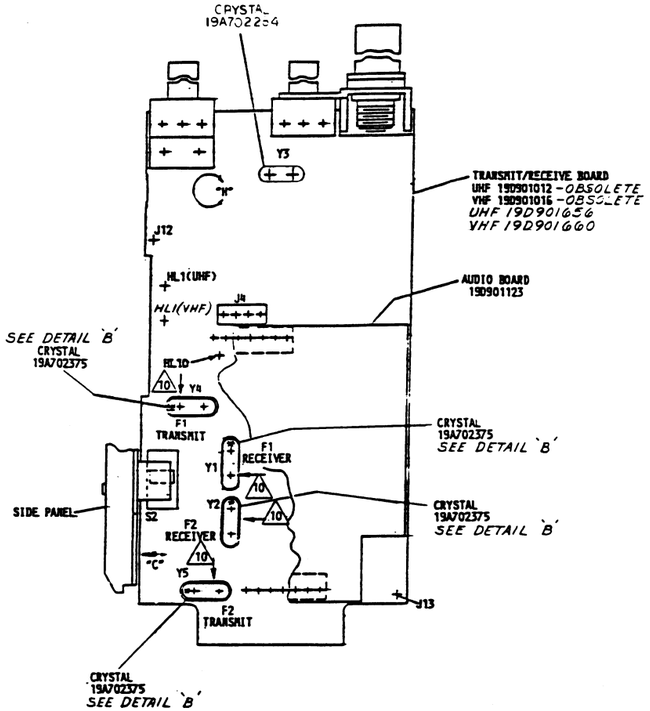
7. CUT RUN ON SOLDER SIDE OF TX/RX BOARD AND ADD JUMPERS AS SHOWN IN DETAIL "E" (SH. #2).

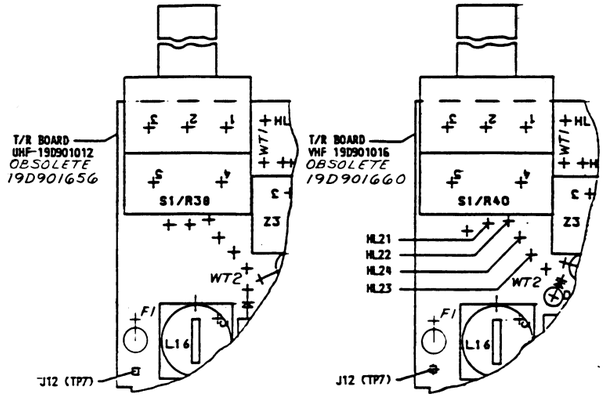
8. *SWITCH STOP IS TO BE INSTALLED UNLESS BTH DIGIT OF COMBINATION NUMBER IS 'C', 'D' OR CRYSTALS ARE INSTALLED IN CHANNEL 2 TX AND/OR RX.*

9. SOLDER ALL ELECTRICAL CONNECTIONS.

10. ORIENT Y1, Y2, Y4 AND Y5 SO THAT DWG. NO. & FREQ. MARKING IS AT SIDE INDICATED. GROUND LEAD MUST BE IN POSITION AS INDICATED BY * (SH. #2

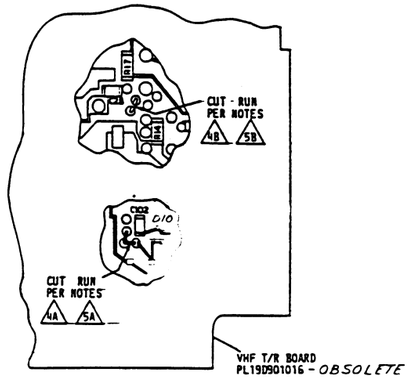
(19D901090, Sh. 1, Rev. 12)



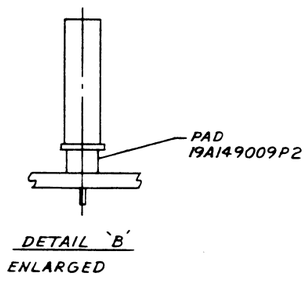


CONNECTIONS FROM SIDE PANEL JACKS TO T/R BOARDS

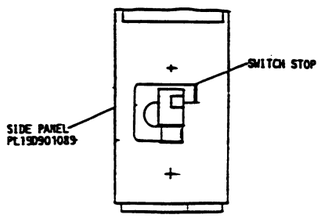
DETAIL "H"



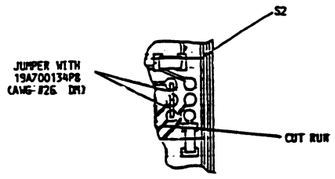
DETAIL "G" SOLDER SIDE VIEW (ENLARGED)



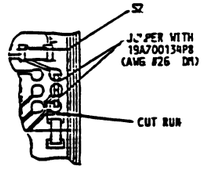
DETAIL 'B' ENLARGED



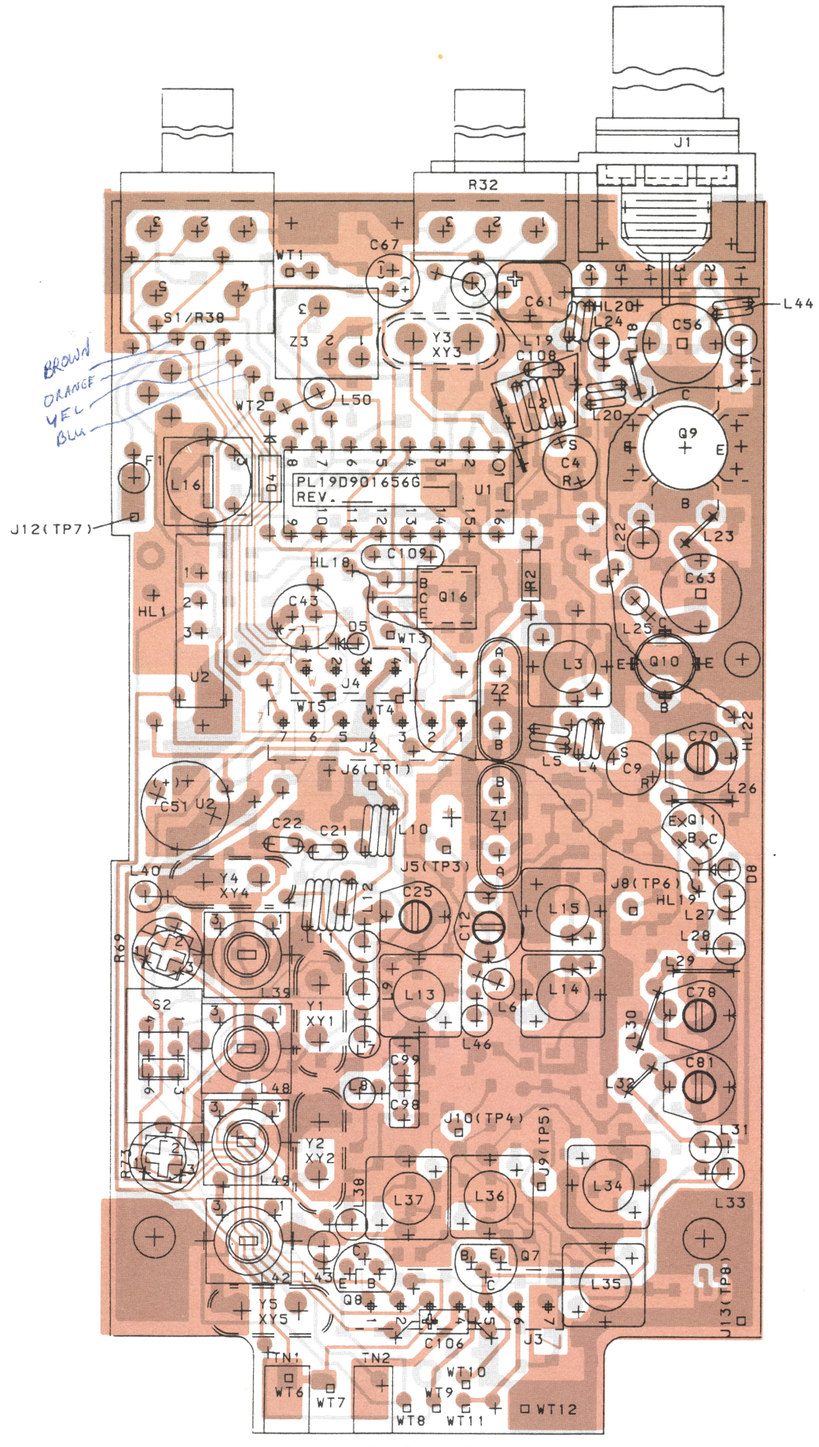
VIEW AT "C"



PART 3 & 4 ONLY
DETAIL "D" 6
SOLDER SIDE VIEW (ENLARGED)

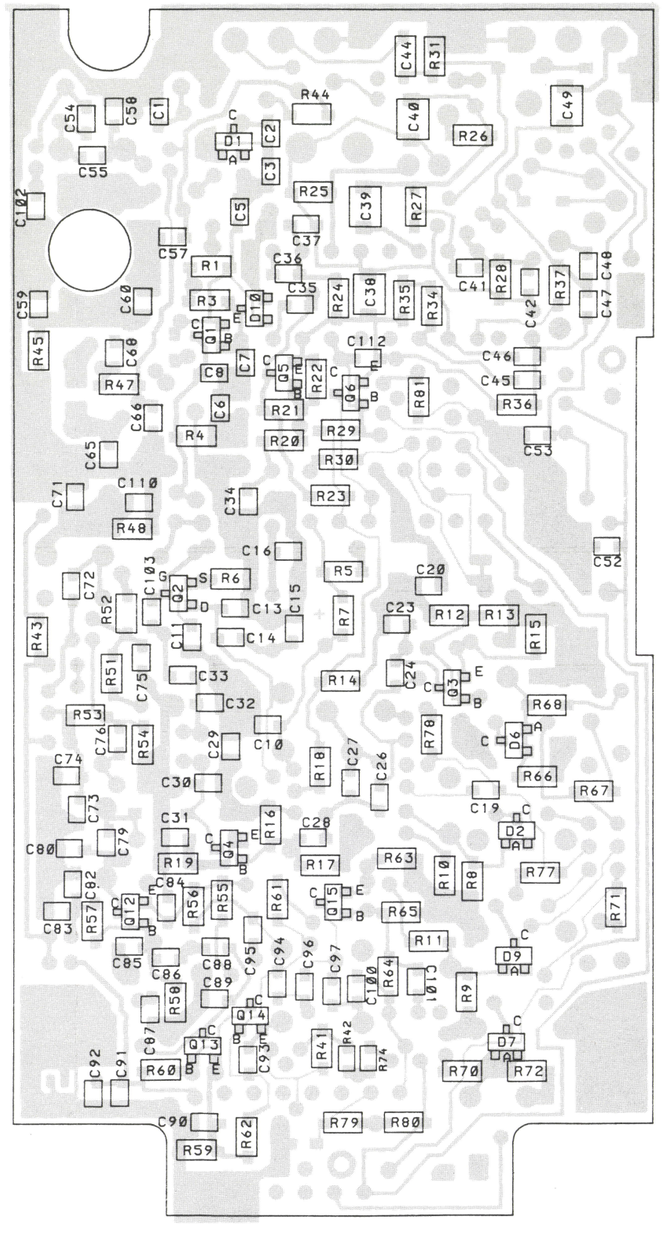


PART 6 & 7 ONLY
DETAIL "E" 7
SOLDER SIDE VIEW (ENLARGED)



FRONT VIEW

(19D901658, Rev. 5)
(19A704667, Sh. 1, Rev. 2)
(19A704667, Sh. 2, Rev. 2)

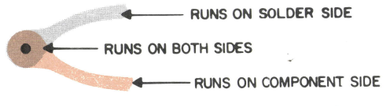


REAR VIEW

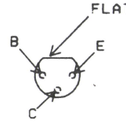
(19D901656, Sh. 1, Rev. 8)
(19A704667, Sh. 2, Rev. 2)

CAUTION

OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC SENSITIVE DEVICES

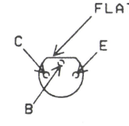


LEAD IDENTIFICATION FOR Q7, Q8 & Q16



TOP VIEW

LEAD IDENTIFICATION FOR Q11

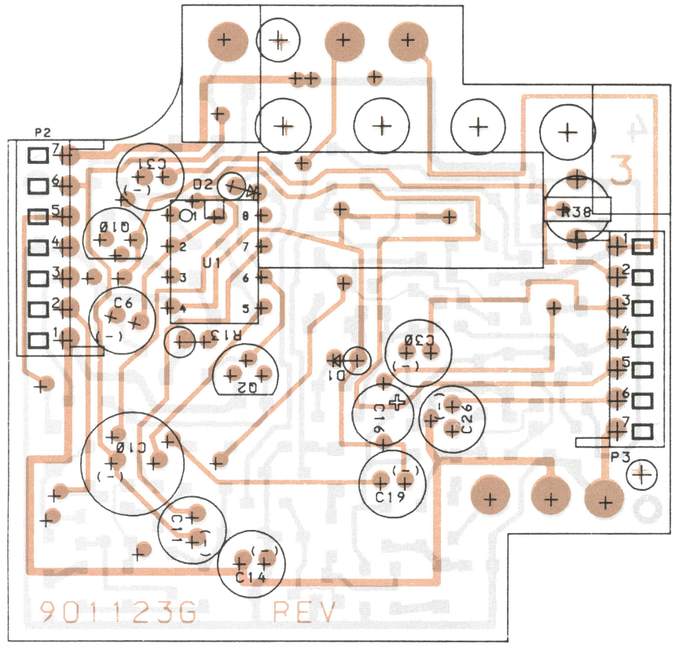


TOP VIEW

NOTE: CASE SHAPE IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

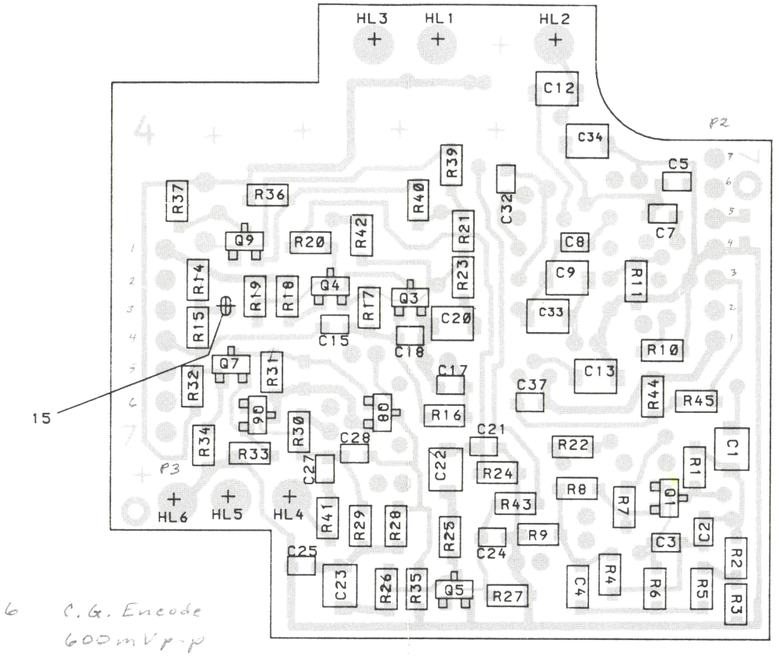
OUTLINE DIAGRAM

TRANSMITTER/RECEIVER BOARD



FRONT SIDE

(19D901124, Rev. 5)
(19A703568, Sh. 1, Rev. 3)
(19A703568, Sh. 2, Rev. 4)



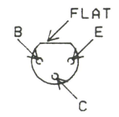
P3-6 C.G. Encode
600mVp-p

BACK SIDE

(19D901123, Rev. 7)
(19A703568, Sh. 2, Rev. 4)

RUNS ON SOLDER SIDE
RUNS ON BOTH SIDES
RUNS ON COMPONENT SIDE

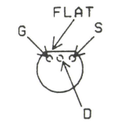
LEAD IDENTIFICATION
FOR Q2



IN-LINE
TOP VIEW

NOTE: CASE SHAPE IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

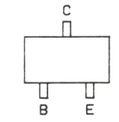
LEAD IDENTIFICATION
FOR Q10



IN-LINE
TOP VIEW

NOTE: CASE SHAPE IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

LEAD IDENTIFICATION
FOR Q1, Q3 THRU Q9



TOP VIEW

OUTLINE DIAGRAM

AUDIO BOARD

14 Issue 3

FREQUENCY SENSITIVE COMPONENTS

REF. NO.	G1 & G13 450-470 MHZ	G2 & G14 470-494 MHZ	G3 & G15 489-512 MHZ	G4 & G16 403-425 MHZ	G5 & G17 420-450 MHZ
C1#	5.6P	5.6P	5.6P	6.8P	5.6P
C2#	6.8P	6.8P	3.9P	8.2P	6.8P
C3#	2.7P	2.7P	2.7P	3.3P	3.3P
C4	0.5-2.5P	0.5-2.5P	0.5-2.5P	1-5P	1-5P
C5#	2.7P	2.7P	2.7P	3.3P	3.3P
C8#	1.2P	0.9P	0.7P	2.2P	1.8P
C19#	100P	100P	100P	68P	150P
C22	68P	68P	68P	120P	120P
C23#	22P	15P	15P	30P	24P
C24#	3.3P	4.7P	4.7P	4.7P	4.7P
C27#	15P	12P	13P	22P	18P
C30#	2.7P	1.8P	1.8P	3.3P	2.7P
C32#	3.3P	2.7P	2.7P	4.3P	3.9P
C54#	10P	8.2P	8.2P	12P	12P
C55#	3.9P	NONE	NONE	8.2P	5.6P
C58#	15P	10P	8.2P	15P	15P
C59#	39P	36P	33P	47P	43P
C60#	39P	36P	33P	47P	43P
C65#	15P	12P	6.8P	24P	22P
C71#	10P	10P	8.2P	15P	10P
C85#	39P	39P	39P	43P	39P
C86#	22P	22P	22P	33P	24P
C87#	39P	33P	33P	51P	43P
C89#	10P	10P	8.2P	12P	12P
C93#	39P	39P	39P	43P	39P
C94#	18P	18P	18P	27P	22P
C95#	47P	47P	47P	56P	47P
C96#	2.7P	2.7P	2.2P	3.3P	2.7P
C97#	30P	27P	27P	39P	36P
C108	6.8P	4.7P	4.7P	6.8P	6.8P
C110#	10P	10P	NONE	15P	10P
L1	2 1/2 TURNS 2.0mm ID	2 1/2 TURNS 1.78mm ID	2 1/2 TURNS 1.78mm ID	2 1/2 TURNS 2.2mm ID	2 1/2 TURNS 2.2mm ID
L4 & L5	2 1/2 TURNS 2.0mm ID	2 1/2 TURNS 2.0mm ID	2 1/2 TURNS 1.78mm ID	2 1/2 TURNS 2.0mm ID	2 1/2 TURNS 2.0mm ID
L7 & L8	1u	1u	1u	1.2u	1.2u
L9	680n	390n	560n	1u	820n
L11	5 1/2 TURNS 3.04mm ID	4 1/2 TURNS 3.04mm ID	4 1/2 TURNS 3.04mm ID	5 1/2 TURNS 3.04mm ID	5 1/2 TURNS 3.04mm ID
L12	150n	120n	120n	150n	150n
L38	270n	270n	220n	470n	390n
L44	1 1/2 TURNS 2.0mm ID	1 1/2 TURNS 1.52mm ID	1 1/2 TURNS 1.52mm ID	1 1/2 TURNS 2.0mm ID	1 1/2 TURNS 2.0mm ID
L45	3 3/4 TURNS 2.54mm ID	3 3/4 TURNS 2.54mm ID	3 3/4 TURNS 2.03mm ID	3 3/4 TURNS 2.54mm ID	3 3/4 TURNS 2.54mm ID
R15#	560	560	560	390	390
R77#	22k	22k	22k	18k	18k
R78#	68k	68k	68k	82k	82k
R79#	47k	47k	47k	47k	47k
R80#	82k	82k	82k	82k	82k

VOLTAGE READINGS:

VOLTAGE READINGS ARE TYPICAL VALUES MEASURED WITH A HIGH IMPEDANCE (20K:10MΩ) MULTI-METER FROM THE INDICATED POINT TO GROUND. CONDITIONS FOR READINGS ARE INDICATED BY THE FOLLOWING KEY:

- R INDICATES VOLTAGES ARE TO BE MEASURED DURING RECEIVE MODE
- T INDICATES MEASUREMENT DURING TRANSMIT
- C INDICATES CONTINUOUS VOLTAGE ALWAYS PRESENT WHEN RADIO IS ON

VOLTAGE READINGS ARE FOR 4 WATT MPI UNITS UNLESS ENCLOSED IN BRACKETS WHICH INDICATES VOLTAGES MEASURED ON 2 WATT MPI UNITS. (EXAMPLE: [+7.5V])

NOTES:

⚠1 PART OF PWB.

3. # IDENTIFIES "CHIP" COMPONENTS (EXAMPLE C57#) WHICH ARE LOCATED ON SOLDER SIDE OF PWB.

4. † FREQUENCY SENSITIVE COMPONENTS, SEE COMPONENT IDENTIFICATION CHART OR PARTS LIST. G1 PART VALUE SHOWN.

5. ALL CHIP RESISTORS ARE 1/8 WATT. ALL OTHER RESISTORS ARE 1/8 WATT UNLESS OTHERWISE SPECIFIED. RESISTOR VALUES IN Ω UNLESS FOLLOWED BY MULTIPLIER k OR M. CAPACITOR VALUES IN F UNLESS FOLLOWED BY MULTIPLIER u,n OR p. INDUCTANCE VALUES IN H UNLESS FOLLOWED BY MULTIPLIER m,u OR n.

⚠6 CUT THIS RUN FOR C8/CCT OPTION.

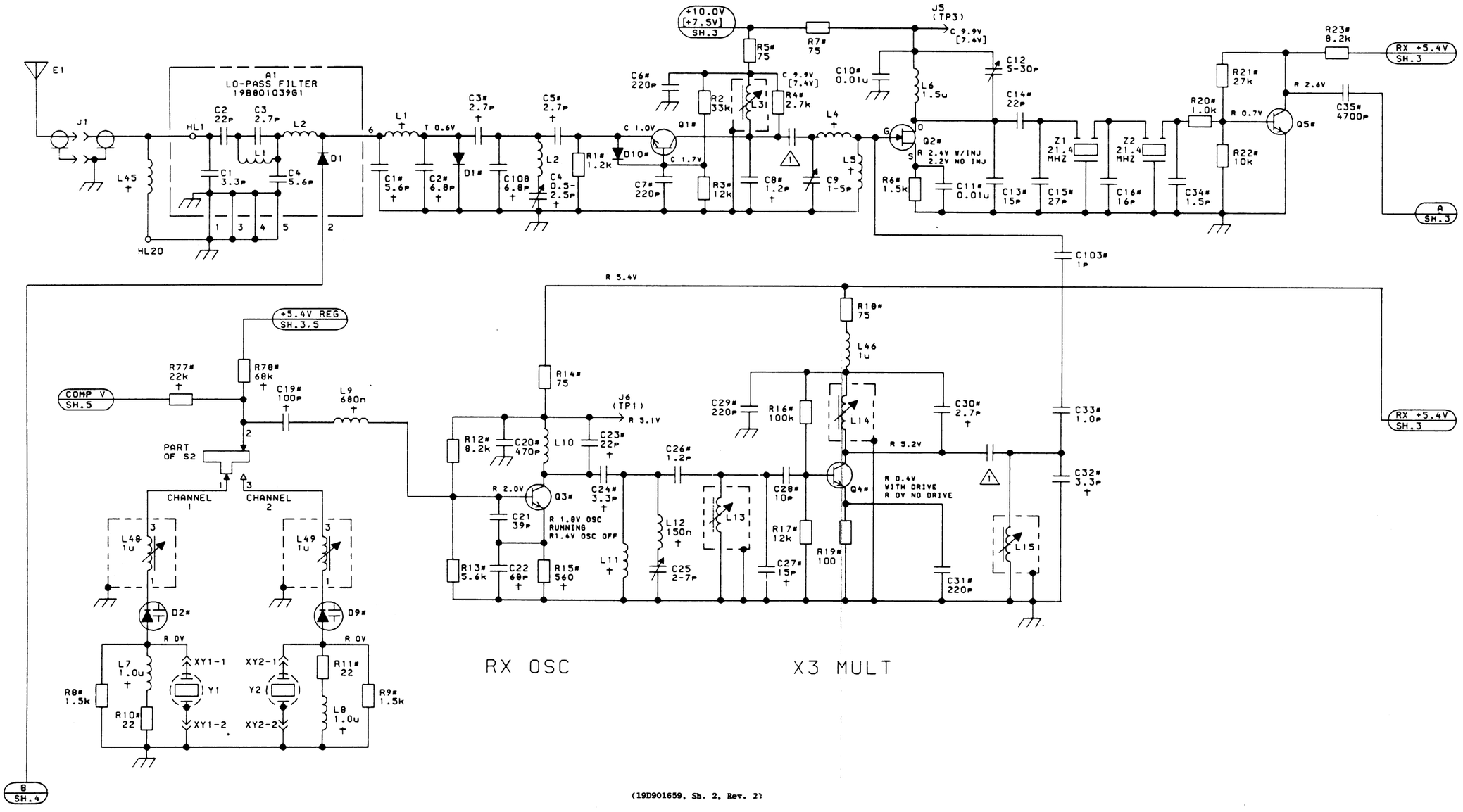
DESCRIPTION	MODEL NO.	REV LTR
UHF 2W/4W MAIN BD 450-470 MHZ	PL19D901656G1	D
UHF 2W/4W MAIN BD 470-494 MHZ	PL19D901656G2	E
UHF 2W/4W MAIN BD 489-512 MHZ	PL19D901656G3	E
UHF 2W/4W MAIN BD 403-425 MHZ	PL19D901656G4	D
UHF 2W/4W MAIN BD 420-450 MHZ	PL19D901656G5	C
UHF 2W/4W MAIN BD 450-470 MHZ	PL19D901656G13	C
UHF 2W/4W MAIN BD 470-494 MHZ	PL19D901656G14	D
UHF 2W/4W MAIN BD 489-512 MHZ	PL19D901656G15	D
UHF 2W/4W MAIN BD 403-425 MHZ	PL19D901656G16	C
UHF 2W/4W MAIN BD 420-450 MHZ	PL19D901656G17	B
AUDIO BOARD (STANDARD)	PL19D90112 3G1	E
AUDIO BOARD (W/DTMF PARTS)	PL19D90112 3G2	E
AUDIO BOARD (STANDARD) (GOLD)	PL19D90112 3G7	A
AUDIO BOARD (W/DTMF PARTS) (GOLD)	PL19D90112 3G8	A
BATTERY (7.5V)	PL19D90063 9G2	
BATTERY (10V)	PL19D90063 9G3	
REAR COVER (2 WATT)	PL19D90108 7G4	
REAR COVER (4 WATT)	PL19D90108 7G2	
SIDE PANEL	PL19D90108 9G1	
FRONT COVER (STANDARD)	PL19D90064 7G1	
FRONT COVER (LICENSEE)	PL19D90064 7G2	
FRONT COVER (STANDARD W/O METAL)	PL19D90064 7G4	
FRONT COVER (STANDARD/DTMF)	PL19D90101 1G1	
FRONT COVER (LICENSEE/DTMF)	PL19D90101 1G2	

(19D901659, Sh. 1, Rev. 11)

SCHEMATIC DIAGRAM

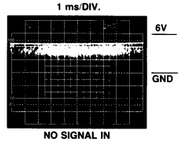
Sheet 1

RX R.F. AMPL MIXER IF PRE-AMPL

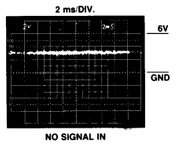


SCHEMATIC DIAGRAM

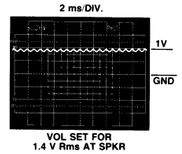
403-512 MHz RX
Sheet 2
16



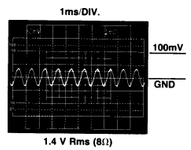
NO SIGNAL IN



NO SIGNAL IN



VOL SET FOR
1.4 V Rms AT SPKR



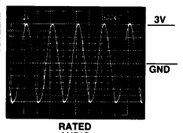
1.4 V Rms (8Ω)

HI PASS FILTER

SQUELCH

VOL SET FOR

500 uS/DIV.



RATED AUDIO

70mV P-P @ 2KuV RF

-3dB BW = ± 7KHz

-100 dBM SINAD @ 21.4 MHz

80mV P-P @ 2KuV RF (-3dB BW = ± 6.5 KHz)

SECOND MIXER

IF/DETECTOR

CHAN. GD. FLTR.

AUDIO AMPLIFIER

TX +10.0V SWITCH

[TX +7.5V] SWITCH

TX +5.4V SWITCH

VOLTAGE REGULATOR

RX +5.4V SWITCH

USED FOR OPTION SWITCH

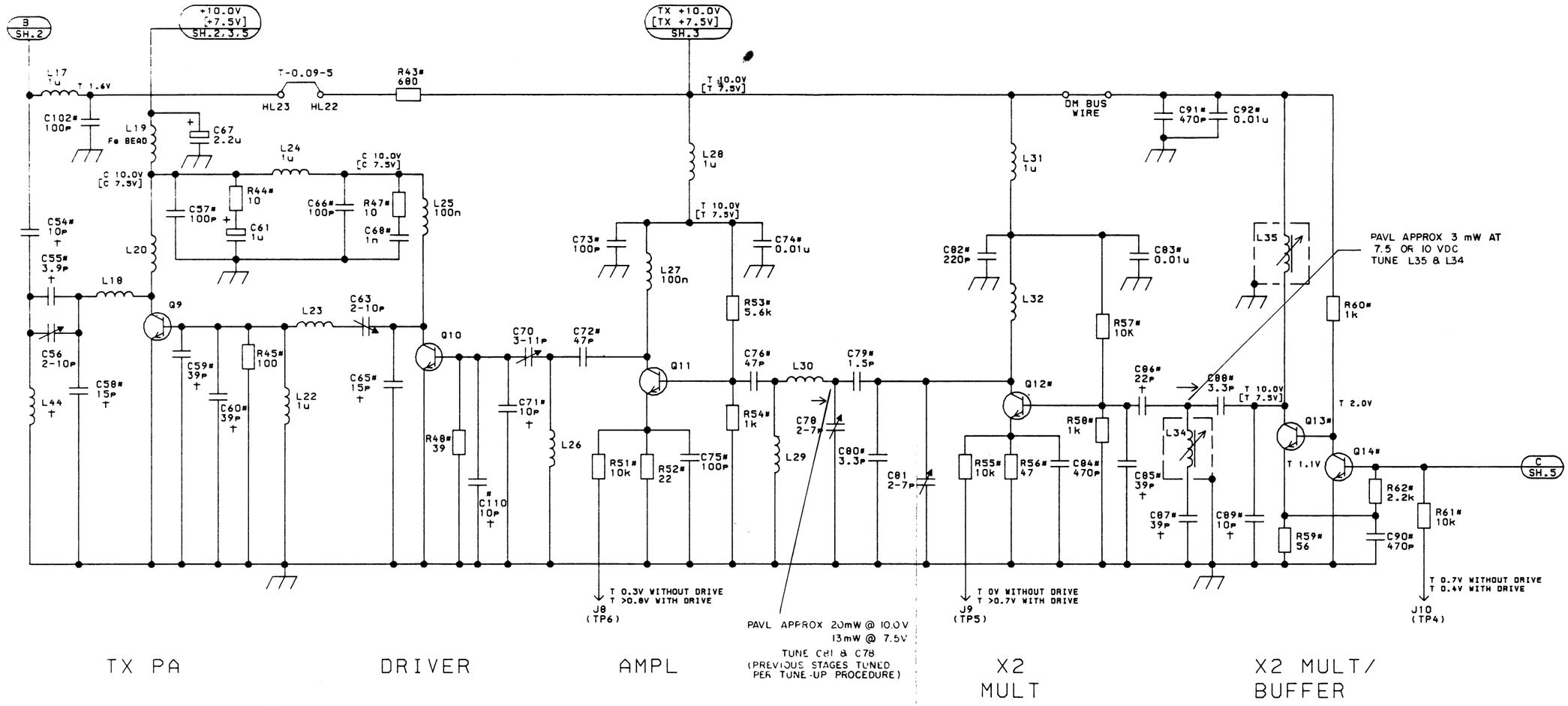
SCHEMATIC DIAGRAM

403-512 MHz RX

Sheet 3

(19D901659, Sh. 3, Rev. 1)

RC4427 SH.3

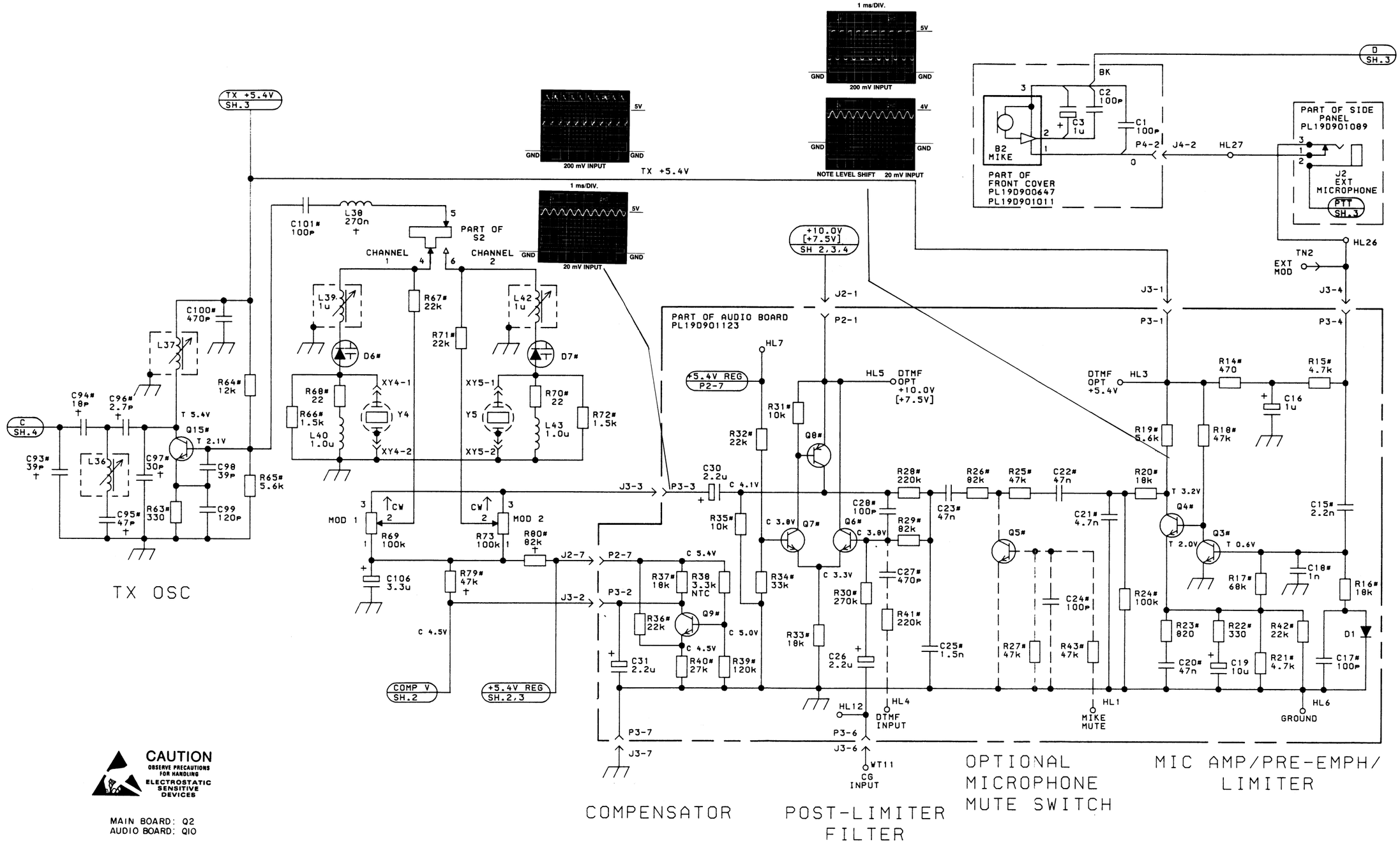


(19D901659, Sh. 4, Rev. 2)

RC4427 SH.4

SCHEMATIC DIAGRAM

403-512 MHz TX
Sheet 4



CAUTION
OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC SENSITIVE DEVICES

MAIN BOARD: Q2
AUDIO BOARD: Q10

RC4427 SH.5

SCHEMATIC DIAGRAM

403-512 MHz TX
Sheet 5
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PARTS LIST

TRANSMIT/RECEIVE BOARD
19D901656G1-G5, G13-G17

ISSUE 4

SYMBOL	GE PART NO.	DESCRIPTION
		19D901656G1 450-470 MHz 19D901656G2 470-494 MHz 19D901656G3 489-512 MHz 19D901656G4 403-425 MHz 19D901656G5 420-450 MHz 19D901656G13 450-470 MHz GOLD CONTACTS 19D901656G14 470-494 MHz GOLD CONTACTS 19D901656G15 489-512 MHZ GOLD CONTACTS 19D901656G16 403-425 MHz GOLD CONTACTS 19D901656G17 420-450 MHz GOLD CONTACTS
		NOTE: WHEN REPLACING BOARDS CARE SHOULD BE TAKEN TO ASSURE BOARDS WITH GOLD CONTACTS ARE NOT INTERMIXED WITH BOARDS HAVING TIN CONTACTS. REPLACE ONLY WITH SAME GRAP NUMBER AS ORIGINAL.
A1		FILTER BOARD 19B801039G1
		- - - - - - - - - - CAPACITORS - - - - - - - - - -
C1	19A700219P14	Ceramic: 3.3 pF ±5%, 100 VDCW, temp coef 0 PPM.
C2	19A700219P40	Ceramic: 22 pF ±10%, 100 VDCW, temp coef 0 PPM.
C3	19A700219P12	Ceramic: 2.7 pF ±5%, 100 VDCW, NPO.
C4	19A700219P20	Ceramic: 5.6 pF ±5%, 100 VDCW, temp coef 0 PPM.
		- - - - - - - - - - DIODES - - - - - - - - - -
D1*	19J706892P2	Silicon, PIN: sim to UM9401.
		- - - - - - - - - - INDUCTORS - - - - - - - - - -
L1	19A702472P3	Coil.
L2	19A702472P1	Coil.
		- - - - - - - - - - CAPACITORS - - - - - - - - - -
C1	19A702061P11	Ceramic: 6.8 pF ±0.5 pF, 50 VDCW, temp coef 0 ±60 PPM. (Used in G4 and G16).
C1	19A702061P10	Ceramic: 5.6 pF ±0.5 pF, 50 VDCW, temp coef 0 ±60 PPM. (Used in G1-G3, G5, G13-15 and G17).
C2	19A702061P11	Ceramic: 6.8 pF ±0.5 pF, 50 VDCW, temp coef 0 ±60 PPM. (Used in G1, G2, G5, G13, G14 and G17).
C2	19A702061P12	Ceramic: 8.2 pF ±0.5 pF, 50 VDCW, temp coef 0 ±60 PPM. (Used in G4 and G16).
C2	19A702061P908	Ceramic: 3.9 pF ±.25 pF, 50 VDCW, temp coef 0 ±120 PPM. (Used in G3 and G15).
C3	19A702061P906	Ceramic: 2.7 pF ±.25 pF, 50 VDCW, temp coef 0 ±120 PPM. (Used in G1-G3 and G13-G15).
C3	19A702061P907	Ceramic: 3.3 pF ±.25 pF, 50 VDCW, temp coef 0 ±120 PPM. (Used in G4, G5, G16 and G17).
C4	19B800873P7	Variable, ceramic: 0.5 to 2.5 pF, 150 VDCW; sim to Johanson 9620. (Used in G1-G3 and G13-G15).
C4	19B800873P8	Variable, ceramic: 1 to 5 pF, 150 VDCW; sim to Johanson 9621. (Used in G4, G5, G16 and G17).
C5	19A702061P906	Ceramic: 2.7 pF ±.25 pF, 50 VDCW, temp coef 0 ±120 PPM. (Used in G1-G3 and G13-G15).
C5	19A702061P907	Ceramic: 3.3 pF ±.25 pF, 50 VDCW, temp coef 0 ±120 PPM. (Used in G4, G5, G16 and G17).
C6 and C7	19A702061P69	Ceramic: 220 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C8	19A702061P902	Ceramic: 1.2 pF ±.25 pF, 50 VDCW, 0 ±250 PPM. (Used in G1 and G13).
C8	19A702236P5	Ceramic: 0.9 pF ±.1 pF, 50 VDCW, 0 ±30 PPM. (Used in G2 and G14).
C8*	19A702236P3	Ceramic: 0.7 pF ±.1 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G3 and G15).
C8	19A702061P905	Ceramic: 2.2 pF ±.25 pF, 50 VDCW, 0 ±250 PPM. (Used in G4 and G16).
C8	19A702061P904	Ceramic: 1.8 pF ±.25 pF, 50 VDCW, temp coef 0 ±250 PPM. (Used in G5 and G17).
C9	19B800873P8	Variable, ceramic: 1 to 5 pF, 150 VDCW; sim to Johanson 9621.
C10 and C11	19A702052P14	Ceramic: 0.01 uF ±10%, 50 VDCW.
C12	19A702168P4	Variable, ceramic: 5.2 to 30 pF, 100 VDCW, temp coef N750+300 PPM; sim to JFD DV2SN30D.
C13	19A702061P21	Ceramic: 15 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM
C14	19A702061P29	Ceramic: 22 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM
C15	19A702061P33	Ceramic: 27 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM
C16	19A702061P23	Ceramic: 16 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM
C19	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1-G3 and G13-G15).
C19	19A702061P53	Ceramic: 68 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C19	19A702061P65	Ceramic: 150 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G5 and G17).
C20	19A702061P77	Ceramic: 470 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C21	19A700226P50	Ceramic: 39 pF ±5%, 100 VDCW, temp coef 0 -750 PPM. (Used in G1-G3, G5, G13-15 and G17).
C21	19A700227P50	Ceramic: 39 pF ±5%, 100 VDCW, temp coef 0 -1500 PPM. (Used in G4 and G16).
C22	19A700229P68	Ceramic: 120 pF ±5%, 100 VDCW, temp coef 0 -3300 PPM. (Used in G5 and G17).
C22	19A700228P59	Ceramic: 68 pF ±5%, 100 VDCW, temp coef 0 -2200 PPM. (Used in G1-G3 and G13-G15).
C22	19A700228P68	Ceramic: 120 pF ±5%, 50 VDCW, temp coef 0 -2200 PPM. (Used in G4 and G16).
C23	19A702061P29	Ceramic: 22 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1 and G13).
C23	19A702061P21	Ceramic: 15 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G2, G3, G14 and G15).
C23	19A702061P35	Ceramic: 30 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C23	19A702061P31	Ceramic: 24 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G5 and G17).
C24	19A702061P907	Ceramic: 3.3 pF ±.25 pF, 50 VDCW, temp coef 0 ±120 PPM. (Used in G1 and G13).
C24	19A702061P909	Ceramic: 4.7 pF ±.25 pF, 50 VDCW, temp coef 0 ±60 PPM. (Used in G2-G5 and G14-G17).
C25	19A702168P1	Variable, ceramic: 2 to 7 pF, 100 VDCW; sim to JFD DV2SN7A.
C26	19A702061P902	Ceramic: 1.2 pF ±.25 pF, 50 VDCW, 0 ±250 PPM.
C27	19A702061P21	Ceramic: 15 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1 and G13).
C27	19A702061P17	Ceramic: 12 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G2 and G14).
C27	19A702061P19	Ceramic: 13 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G3 and G15).
C27	19A702061P29	Ceramic: 22 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C27	19A702061P25	Ceramic: 18 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G5 and G17).
C28	19A702061P13	Ceramic: 10 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM
C29	19A702061P69	Ceramic: 220 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C30	19A702061P906	Ceramic: 2.7 pF ±.25 pF, 50 VDCW, temp coef 0 ±120 PPM. (Used in G1, G5, G13 and G17).
C30	19A702061P904	Ceramic: 1.8 pF ±.25 pF, 50 VDCW, temp coef 0 ±250 PPM. (Used in G2, G3 and G14 and G15).
C30	19A702061P907	Ceramic: 3.3 pF ±.25 pF, 50 VDCW, temp coef 0 ±120 PPM. (Used in G4 and G16).
C31	19A702061P69	Ceramic: 220 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C32	19A702061P907	Ceramic: 3.3 pF ±.25 pF, 50 VDCW, temp coef 0 ±120 PPM. (Used in G1 and G13).
C32	19A702061P906	Ceramic: 2.7 pF ±.25 pF, 50 VDCW, temp coef 0 ±120 PPM. (Used in G2, G3, G14 and G15).
C32	19A702236P16	Ceramic: 4.3 pF ±.25 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C32	19A702061P908	Ceramic: 3.9 pF ±.25 pF, 50 VDCW, temp coef 0 ±120 PPM. (Used in G5 and G17).
C33	19A702236P6	Ceramic: 1.0 pF ±.25 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4, G5, G16 and G17).
C33	19A702236P1	Ceramic: 0.5 pF ±.1 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1-G3 and G13-G15).
C34	19A702061P903	Ceramic: 1.5 pF ±.25 pF, 50 VDCW, temp coef 0 ±250 PPM.
C35	19A702052P10	Ceramic: 4700 pF ±10%, 50 VDCW.
C36	19A702061P37	Ceramic: 33 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM
C37	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C38 thru C40	19A702052P26	Ceramic: 0.1 uF ±10%, 50 VDCW.
C41	19A702061P13	Ceramic: 10 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM
C42	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C43	19B800755P4	Electrolytic: 10 uF ±20%, 16 VDCW.
C44	19A702052P28	Ceramic: 0.022 uF ±10%, 50 VDCW.
C45	19A702052P105	Ceramic: 1000 pF ±5%, 50 VDCW.
C46	19A702052P110	Ceramic: 4700 pF ±5%, 50 VDCW.
C47	19A702052P112	Ceramic: 6800 pF ±5%, 50 VDCW.
C48	19A702052P14	Ceramic: 0.01 uF ±10%, 50 VDCW.
C49	19A702052P26	Ceramic: 0.1 uF ±10%, 50 VDCW.
C51	19A700003P9	Tantalum: 47 uF ±20%, 6.3 VDCW.
C52 and C53	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C54	19A702236P25	Ceramic: 10 pF ±.5 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1 and G13).
C54	19A702236P23	Ceramic: 8.2 pF ±.25 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G2, G3, G14 and G15).
C54	19A702236P28	Ceramic: 12 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4, G5, G16 and G17).
C55	19A702236P15	Ceramic: 3.9 pF ±.25 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1 and G13).
C55	19A702236P23	Ceramic: 8.2 pF ±.25 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C55	19A702236P19	Ceramic: 5.6 pF ±.5 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G5 and G17).
C56	19B800873P3	Variable, ceramic: 2.5 to 10 pF, 150 VDCW; sim to Johanson 9611.
C57	19A702236P50	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C58	19A702236P30	Ceramic: 15 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4, G5, G16 and G17). & also G1 & G13
C58	19A702236P25	Ceramic: 10 pF ±.5 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G2 and G14).
C58	19A702236P23	Ceramic: 8.2 pF ±.25 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G3 and G15).
C59	19A702236P40	Ceramic: 39 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1 and G13).
C59	19A702236P39	Ceramic: 36 pF ±.25 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G2 and G14).
C59	19A702236P38	Ceramic: 33 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G3 and G15).
C59	19A702236P42	Ceramic: 47 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C59	19A702236P41	Ceramic: 43 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G5 and G17).
C60	19A702236P41	Ceramic: 43 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G5 and G17).

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

SYMBOL	GE PART NO.	DESCRIPTION
C60	19A702236P40	Ceramic: 39 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1 and G13).
C60	19A702236P38	Ceramic: 33 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G3 and G15).
C60	19A702236P39	Ceramic: 36 pF ±.25 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G2 and G14).
C60	19A702236P42	Ceramic: 47 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C61	19A700003P4	Tantalum: 1 uF ±20%, 35 VDCW.
C63	19B800873P3	Variable, ceramic: 2.5 to 10 pF, 150 VDCW; sim to Johanson 9611.
C65	19A702236P28	Ceramic: 12 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G2 and G14).
C65	19A702236P35	Ceramic: 24 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C65	19A702236P34	Ceramic: 22 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G5 and G17).
C65	19A702236P30	Ceramic: 15 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1 and G13).
C65*	19A702236P21	Ceramic: 6.8 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G3 and G15).
C66	19A702236P50	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C67	19A703324P2	Electrolytic: 2.2 uF ±20%, 50 VDCW.
C68	19A702052P5	Ceramic: 1000 pF ±10%, 50 VDCW.
C70	19A702168P2	Variable, cermic: 3 to 11 pF 100 VDCW, temp coef N450+300 PPM; sim to JFD DV2SN11C.
C71	19A702236P25	Ceramic: 10 pF ±.5 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1, G2, G5, G13, G14 and G17).
C71	19A702236P30	Ceramic: 15 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C71	19A702236P23	Ceramic: 8.2 pF ±.25 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G3 and G15).
C72	19A702061P45	Ceramic: 47 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM
C73	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C74	19A702052P14	Ceramic: 0.01 uF ±10%, 50 VDCW.
C75	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C76	19A702061P45	Ceramic: 47 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM
C78	19A702168P1	Variable, ceramic: 2 to 7 pF, 100 VDCW; sim to JFD DV2SN7A.
C79	19A702061P3	Ceramic: 1.5 pF ±0.5 pF, 50 VDCW, temp coef 0 ±250 PPM.
C80	19A702061P7	Ceramic: 3.3 pF ±0.5 pF, 50 VDCW, temp coef 0 ±120 PPM.
C81	19A702168P1	Variable, ceramic: 2 to 7 pF, 100 VDCW; sim to JFD DV2SN7A.
C82	19A702061P69	Ceramic: 220 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C83	19A702052P14	Ceramic: 0.01 uF ±10%, 50 VDCW.
C84	19A702061P77	Ceramic: 470 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C85	19A702061P41	Ceramic: 39 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1-G3, G5, G13-G15 and G17).
C85	19A702061P43	Ceramic: 43 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C86	19A702061P29	Ceramic: 22 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1-G3 and G13-G15).
C86*	19A702061P37	Ceramic: 33 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C86	19A702061P31	Ceramic: 24 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G5 and G17).
C87	19A702061P41	Ceramic: 39 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1 and G13).
C87	19A702061P37	Ceramic: 33 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G2, G3, G14 and G15).
C87	19A702061P47	Ceramic: 51 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).

SYMBOL	GE PART NO.	DESCRIPTION
C87	19A702061P43	Ceramic: 43 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G5 and G17).
C88	19A702061P7	Ceramic: 3.3 pF ±0.5 pF, 50 VDCW, temp coef 0 ±120 PPM.
C89	19A702061P13	Ceramic: 10 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1, G2, G13 and G14).
C89	19A702061P12	Ceramic: 8.2 pF ±0.5 pF, 50 VDCW, temp coef 0 ±60 PPM. (Used in G3 and G15).
C89	19A702061P17	Ceramic: 12 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4, G5, G16 and G17).
C90 and C91	19A702061P77	Ceramic: 470 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C92	19A702052P14	Ceramic: 0.01 uF ±10%, 50 VDCW.
C93	19A702061P41	Ceramic: 39 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1-G3, G5, G13-G15 and G17).
C93	19A702061P43	Ceramic: 43 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C94	19A702061P25	Ceramic: 18 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1-G3 and G13-G15).
C94	19A702061P33	Ceramic: 27 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C94	19A702061P29	Ceramic: 22 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G5 and G17).
C95	19A702061P45	Ceramic: 47 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1-G3, G5, G13-G15 and G17).
C95	19A702061P49	Ceramic: 56 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C96	19A702061P906	Ceramic: 2.7 pF ±.25 pF, 50 VDCW, temp coef 0 ±120 PPM. (Used in G1, G2, G5, G13, G14 and G17).
C96	19A702061P905	Ceramic: 2.2 pF ±.25 pF, 50 VDCW, temp coef 0 ±250 PPM. (Used in G3 and G15).
C96	19A702061P907	Ceramic: 3.3 pF ±.25 pF, 50 VDCW, temp coef 0 ±120 PPM. (Used in G4 and G16).
C97	19A702061P35	Ceramic: 30 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1 and G13).
C97	19A702061P33	Ceramic: 27 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G2, G3, G14 and G15).
C97	19A702061P41	Ceramic: 39 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C97	19A702061P39	Ceramic: 36 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G5 and G17).
C98	19A700227P50	Ceramic: 39 pF ±5%, 100 VDCW, temp coef 0 -1500 PPM. (Used in G1, G4, G5, G13, G16 and G17).
C98	19A700226P50	Ceramic: 39 pF ±5%, 100 VDCW, temp coef 0 -750 PPM. (Used in G2 and G14).
C98	19A700228P50	Ceramic: 39 pF ±5%, 50 VDCW, temp coef 0 -2200 PPM. (Used in G3 and G15).
C99	19A700229P68	Ceramic: 120 pF ±5%, 100 VDCW, temp coef 0 -3300 PPM. (Used in G1, G2, G13 and G14).
C99	19A700227P68	Ceramic: 120 pF ±5%,50 VDCW, temp coef 0 -1500 PPM. (Used in G3 and G15).
C99	19A700228P68	Ceramic: 120 pF ±5%, 50 VDCW, temp coef 0 -2200 PPM. (Used in G4 and G16).
C99	19A700230P68	Ceramic: 120 pF ±5%, 50 VDCW, temp coef 0 -4200 PPM. (Used in G5 and G17).
C100	19A702052P3	Ceramic: 470 pF ±10%, 50 VDCW.
C101 and C102	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C103	19A702236P6	Ceramic: 1.0 pF ±.25 pF, 50 VDCW, temp coef 0 ±30 PPM.
C106	19B800650P15	Tantalum: 3.3 uF ±20%, 10 VDCW.
C108	19A700219P18	Ceramic: 4.7 pF ±5%, 100 VDCW, temp coef 0 PPM. (Used in G2, G3, G14 and G15).
C108	19A700219P22	Ceramic: 6.8 pF ±5%, 100 VDCW, temp coef 0 PPM. (Used in G1, G4, G5, G13, G16 and G17).
C109	19A116192P14	Ceramic: 0.1 uF ±20%, 50 VDCW; sim to Erie USCC CW20C104-M2.

SYMBOL	GE PART NO.	DESCRIPTION
C110	19A702236P25	Ceramic: 10 pF ±.5 pF, 50 VDCW, temp coef 0 ±30 PPM. (Used in G1, G2, G5, G13, G14 and G17).
C110	19A702236P30	Ceramic: 15 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G4 and G16).
C112	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
		- - - - - - - - - - DIODES - - - - - - - - - -
D1	19A700155P2	Silicon; sim to Bat 18.
D2	19A700079P3	Silicon; sim to BBY 31.
D4 and D5	19A702015P1	Silicon; sim to IN458A.
D6 and D7	19A700079P3	Silicon; sim to BBY 31.
D8	19A702015P2	Silicon; sim to IN458A.
D9	19A700079P3	Silicon; sim to BBY 31.
D10	19A700155P2	Silicon; sim to Bat 18.
		- - - - - - - - - - FUSES - - - - - - - - - -
F1	19A702169P9	Enclosed link: rated 3 amps @ 125 v; sim to Littelfuse 255003.
		- - - - - - - - - - JACKS - - - - - - - - - -
J1	19B801108G1	Connector, coax: BNC Series, 500 VRMS.
J2 and J3	19A703248P4	Contact, electrical. (Quantity 7 each). (Groups 1-5).
J2 and J3	19A703248P14	Contact, electrical. (Groups 13-17).
J4	19A703248P1	Contact, electrical. (Quantity 4).
J5 and J6	19A703248P1	Contact, electrical.
J8	19A703248P1	Contact, electrical.
J9	19A703248P4	Contact, electrical.
J10	19A703248P1	Contact, electrical.
J12 and J13	19A703248P1	Contact, electrical.
		- - - - - - - - - - INDUCTORS - - - - - - - - - -
L1	19A702472P32	Coil. (Used in G2, G3, G14 and G15).
L1	19A702472P33	Coil. (Used in G4, G5, G16 and G17).
L1	19A702472P3	Coil. (Used in G1 and G13).
L2	19A702472P30	Coil.
L3	19C850826P211	Coil, RF: sim to Paul Smith SK-800-1.
L4 and L5	19A702472P3	Coil. (Used in G1, G2, G4, G5, G13, G14, G16 and G17).
L4 and L5	19A702472P32	Coil. (Used in G3 and G15).
L6	19A700024P15	Coil, RF: 1.5 uH ±10%.
L7 and L8	19A700024P13	Coil, RF: 1.0 uH ±10%. (Used in G1-G3 and G13-G15).
L7 and L8	19A700024P14	Coil, RF: 1.2 uH ±10%. (Used in G4, G5, G16 and G17).
L9	19A700024P11	Coil, RF: 680 nH ±10%. (Used in G1 and G13).
L9*	19A700024P8	Coil, RF: 390 nH ±10%. (Used in G2 and G14).
L9	19A700024P10	Coil, RF: 560 nH ±10%. (Used in G3 and G15).
L9	19A700024P13	Coil, RF: 1.0 uH ±10%. (Used in G4 and G16).
L9	19A700024P12	Coil, RF: 820 nH ±10%. (Used in G5 and G17).

SYMBOL	GE PART NO.	DESCRIPTION
L10	19A702472P24	Coil.
L11	19A702472P26	Coil. (Used in G1, G4, G5, G13, G16 and G17).
L11	19A702472P25	Coil. (Used in G2, G3, G14 and G15).
L12	19A700024P3	Coil, RF: 150 nH ±10%. (Used in G1, G4, G5, G13, G16 and G17).
L12	19A700024P2	Coil, RF: 120 nH ±10%. (Used in G2, G3, G14 and G15).
L13	19C850826P322	Coil, RF: sim to Paul Smith SK-800-1.
L14	19C850826P221	Coil, RF: sim to Paul Smith SK-800-1.
L15	19C850826P211	Coil, RF: sim to Paul Smith SK-800-1.
L16	19A702213P1	Coil, RF: 1.0 mH ±6%; sim to TOKO 126AN-A5316HM.
L17	19A700024P13	Coil, RF: 1.0 uH ±10%.
L18	19A702988P1	Coil.
L19	19A702473G1	Coil.
L20	19A702472P8	Coil.
L22	19A700024P13	Coil, RF: 1.0 uH ±10%.
L23	19A702472P3	Coil.
L24	19A700024P13	Coil, RF: 1.0 uH ±10%.
L25	19A700024P1	Coil, RF: 100 nH ±10%, 0.08 ohms DC res max, 100 v.
L26	19A702474P4	Coil.
L27	19A700024P1	Coil, RF: 100 nH ±10%, 0.08 ohms DC res max, 100 v.
L28	19A700024P13	Coil, RF: 1.0 uH ±10%.
L29 and L30	19A702474P5	Coil.
L31	19A700024P13	Coil, RF: 1.0 uH ±10%.
L32	19A702474P1	Coil.
L33	19A700024P13	Coil, RF: 1.0 uH ±10%.
L34 and L35	19C850826P212	Coil, RF: sim to Paul Smith SK-800-1.
L36	19C850826P612	Coil, RF; sim to Paul Smith SK-800-1.
L37	19C850826P312	Coil, RF: sim to Paul Smith SK-800-1.
L38	19A700024P6	Coil. (Used in G1, G2, G13 and G14).
L38	19A700024P5	Coil, RF: 220 nH ±10%. (Used in G3 and G15).
L38	19A700024P9	Coil, RF: 470 nH ±10%. (Used in G4 and G16).
L38	19A700024P8	Coil, RF: 390 nH ±10%. (Used in G5 and G17).
L39	19A703602G1	Coil, RF. Includes 19B800827P24 tuning slug.
L40	19A700024P13	Coil, RF: 1.0 uH ±10%.
L42	19A703602G1	Coil, RF. Includes 19B800827P24 tuning slug.
L43	19A700024P13	Coil, RF: 1.0 uH ±10%.
L44	19A702472P34	Coil. (Used in G2, G3, G14 and G15).
L44	19A702472P7	Coil. (Used in G1, G4, G5, G13, G16 and G17).
L45	19A703161P2	Coil. (Used in G1, G2, G4, G5, G13, G14, G16 and G17).
L45	19A703161P1	Coil. (Used in G3 and G15).
L46	19A700024P13	Coil, RF: 1.0 uH ±10%.
L48 and L49	19B801465P1	Coil, RF.
L50	19A700024P13	Coil, RF: 1.0 uH ±10%.
		- - - - - - - - - - TRANSISTORS - - - - - - - - - -
Q1	19A702413P2	Silicon, NPN; sim to Phillips BFR92.
Q2	19A703795P1	N Type: field effect; sim to MMBF4416.
Q3	19A700092P2	Silicon, NPN.
Q4	19A700236P4	Silicon, NPN.

SYMBOL	GE PART NO.	DESCRIPTION
Q5	19A700092P2	Silicon, NPN.
Q6	19A700076P2	Silicon, NPN.
Q7 and Q8	19A700026P1	Silicon, PNP.
Q9	19A702448P1	Silicon, NPN; sim to 2N5945.
Q10	19A701940P3	Silicon, NPN; sim to SRF-516. (Used in G1, G2, G4, G5, G13, G14, G16, G17).
Q10*	19A701940P4	Silicon, NPN; sim to SRF-516. (Used in G3 and G15).
Q11	19A701808P3	Silicon, NPN; sim to MPS 6595.
Q12 and Q13	19A700236P4	Silicon, NPN.
Q14 and Q15	19A700092P2	Silicon, NPN.
Q16	19A700026P1	Silicon, PNP.
		- - - - - - - - - - RESISTORS - - - - - - - - - -
R1	19B800607P122	Metal film: 1.2K ohms ±5%, 200 VDCW, 1/8 w.
R2	19A702585P99	Composition: 33K ohms ±5%, 150 VDCW, 1/8 w.
R3	19B800607P123	Metal film: 12K ohms ±5%, 200 VDCW, 1/8 w.
R4*	19B800607P272	Metal film: 2.7K ohms ±5%, 200 VDCW, 1/8 w.
R5	19B800607P750	Metal film: 75 ohms ±5%, 200 VDCW, 1/8 w.
R6	19B800607P152	Metal film: 1.5K ohms ±5%, 200 VDCW, 1/8 w.
R7	19B800607P750	Metal film: 75 ohms ±5%, 200 VDCW, 1/8 w.
R8 and R9	19B800607P152	Metal film: 1.5K ohms ±5%, 200 VDCW, 1/8 w.
R10	19B800607P220	Metal film: 22 ohms ±5%, 200 VDCW, 1/8 w. (Used in G1-G3 and G13-G15).
R10	19B800607P181	Metal film: 180 ohms ±5%, 200 VDCW, 1/8 w. (Used in G4, G5, G16 and G17).
R11	19B800607P220	Metal film: 22 ohms ±5%, 200 VDCW, 1/8 w. (Used in G1-G3 and G13-G15).
R11	19B800607P181	Metal film: 180 ohms ±5%, 200 VDCW, 1/8 w. (Used in G4, G5, G16 and G17).
R12	19B800607P822	Metal film: 8.2K ohms ±5%, 200 VDCW, 1/8 w.
R13	19B800607P562	Metal film: 5.6K ohms ±5%, 200 VDCW, 1/8 w.
R14	19B800607P750	Metal film: 75 ohms ±5%, 200 VDCW, 1/8 w.
R15	19B800607P561	Metal film: 560 ohms ±5%, 200 VDCW, 1/8 w. (Used in G1-G3 and G13-G15).
R15	19B800607P391	Metal film: 390 ohms ±5%, 200 VDCW, 1/8 w. (Used in G4, G5, G16 and G17).
R16	19B800607P104	Metal film: 100K ohms ±5%, 200 VDCW, 1/8 w.
R17	19B800607P123	Metal film: 12K ohms ±5%, 200 VDCW, 1/8 w.
R18	19B800607P750	Metal film: 75 ohms ±5%, 200 VDCW, 1/8 w.
R19	19B800607P101	Metal film: 100 ohms ±5%, 200 VDCW, 1/8 w.
R20	19B800607P102	Metal film: 1K ohms ±5%, 200 VDCW, 1/8 w.
R21	19B800607P273	Metal film: 27K ohms ±5%, 200 VDCW, 1/8 w.
R22	19B800607P103	Metal film: 10K ohms ±5%, 200 VDCW, 1/8 w.
R23	19B800607P822	Metal film: 8.2K ohms ±5%, 200 VDCW, 1/8 w.
R24	19B800607P473	Metal film: 47K ohms ±5%, 200 VDCW, 1/8 w.
R25 and R26	19B800607P222	Metal film: 2.2K ohms ±5%, 200 VDCW, 1/8 w.
R27	19B800607P473	Metal film: 47K ohms ±5%, 200 VDCW, 1/8 w.
R28	19B800607P223	Metal film: 22K ohms ±5%, 200 VDCW, 1/8 w.
R29	19B800607P153	Metal film: 15K ohms ±5%, 200 VDCW, 1/8 w.
R30	19B800607P563	Metal film: 56K ohms ±5%, 200 VDCW, 1/8 w.
R31	19B800607P682	Metal film: 6.8K ohms ±5%, 200 VDCW, 1/8 w.
R32	19B800762P1	Variable, carbon film: 5K ohms ±20%, 150 VDCW, .1 w; sim to TOCOS RPR124.

SYMBOL	GE PART NO.	DESCRIPTION
R34	19B800607P563	Metal film: 56K ohms ±5%, 200 VDCW, 1/8 w.
R35	19B800607P823	Metal film: 82K ohms ±5%, 200 VDCW, 1/8 w.
R36	19B800607P152	Metal film: 1.5K ohms ±5%, 200 VDCW, 1/8 w.
R37	19B800607P821	Metal film: 820 ohms ±5%, 200 VDCW, 1/8 w.
R38	19B801350P1	Variable, 5 ohms to 10K ohms ±20%, 1/4 w.
R41	19B800607P471	Metal film: 470 ohms ±5%, 200 VDCW, 1/8 w.
R42	19B801251P471	Composition: 470 ohms ±5%, 150 VDCW, 1/8 w.
R43	19B800607P681	Metal film: 680 ohms ±5%, 200 VDCW, 1/8 w.
R44	19B800607P100	Metal film: 10 ohms ±5%, 200 VDCW, 1/8 w.
R45	19B800607P101	Metal film: 100 ohms ±5%, 200 VDCW, 1/8 w.
R47	19B800607P100	Metal film: 10 ohms ±5%, 200 VDCW, 1/8 w.
R48*	19B800607P390	Metal film: 39 ohms ±5%, 200 VDCW, 1/8 w.
R51	19B800607P103	Metal film: 10K ohms ±5%, 200 VDCW, 1/8 w.
R52	19B800607P220	Metal film: 22 ohms ±5%, 200 VDCW, 1/8 w.
R53	19B800607P562	Metal film: 5.6K ohms ±5%, 200 VDCW, 1/8 w.
R54	19B800607P102	Metal film: 1K ohms ±5%, 200 VDCW, 1/8 w.
R55	19B800607P103	Metal film: 10K ohms ±5%, 200 VDCW, 1/8 w.
R56	19B800607P470	Metal film: 47 ohms ±5%, 200 VDCW, 1/8 w.
R57	19B800607P103	Metal film: 10K ohms ±5%, 200 VDCW, 1/8 w.
R58	19B800607P102	Metal film: 1K ohms ±5%, 200 VDCW, 1/8 w.
R59	19B800607P560	Metal film: 56 ohms ±5%, 200 VDCW, 1/8 w.
R60	19B800607P102	Metal film: 1K ohms ±5%, 200 VDCW, 1/8 w.
R61	19B800607P103	Metal film: 10K ohms ±5%, 200 VDCW, 1/8 w.
R62	19B800607P222	Metal film: 2.2K ohms ±5%, 200 VDCW, 1/8 w.
R63	19B800607P331	Metal film: 330 ohms ±5%, 200 VDCW, 1/8 w.
R64	19B800607P123	Metal film: 12K ohms ±5%, 200 VDCW, 1/8 w.
R65	19B800607P562	Metal film: 5.6K ohms ±5%, 200 VDCW, 1/8 w.
R66	19B800607P152	Metal film: 1.5K ohms ±5%, 200 VDCW, 1/8 w.
R67	19B800607P223	Metal film: 22K ohms ±5%, 200 VDCW, 1/8 w.
R68	19B800607P220	Metal film: 22 ohms ±5%, 200 VDCW, 1/8 w.
R69	19B800751P16	Variable, solid carbon: 100K ohms ±25%, 0.05 w; sim to ALSP H0651A.
R70	19B800607P220	Metal film: 22 ohms ±5%, 200 VDCW, 1/8 w.
R71	19B800607P223	Metal film: 22K ohms ±5%, 200 VDCW, 1/8 w.
R72	19B800607P152	Metal film: 1.5K ohms ±5%, 200 VDCW, 1/8 w.
R73	19B800751P16	Variable, solid carbon: 100K ohms ±25%, 0.05 w; sim to ALSP H0651A.
R74	19B801251P222	Composition: 2.2K ohms ±5%, 150 VDCW, 1/8 w.
R77	19B800607P223	Metal film: 22K ohms ±5%, 200 VDCW, 1/8 w. (Used in G1-G3 and G13-G15).
R77	19B800607P183	Metal film: 18K ohms ±5%, 200 VDCW, 1/8 w. (Used in G4, G5, G16 and G17).
R78	19B800607P823	Metal film: 82K ohms ±5%, 200 VDCW, 1/8 w. (Used in G4, G5, G16 and G17).
R78	19B800607P683	Metal film: 68K ohms ±5%, 200 VDCW, 1/8 w. (Used in G1-G3 and G13-G15).
R79	19B800607P473	Metal film: 47K ohms ±5%, 200 VDCW, 1/8 w.
R80	19B800607P823	Metal film: 82K ohms ±5%, 200 VDCW, 1/8 w.
R81	19B800607P123	Metal film: 12K ohms ±5%, 200 VDCW, 1/8 w.
		- - - - - - - - - - SWITCHES - - - - - - - - - -
S1		(Part of R38).
S2	19A702244P1	Slide switch: DPDT, contact rating 1 mA @ 10 VDC; sim to Alps SSSO2200.
		- - - - - - - - INTEGRATED CIRCUITS - - - - - - - -
U1	19A701780P1	Linear: IF AMPLIFIER AND DETECTOR.
U2	19D438002G1	5.4 Volt Voltage Regulator.

SYMBOL	GE PART NO.	DESCRIPTION
		- - - - - - - - - - TERMINALS - - - - - - - - - -
WT1* thru WT12	19A701329P1	Contact, electrical.
		- - - - - - - - - - SOCKETS - - - - - - - - - -
XY1 and XY2	19A115834P1	Contact, electrical: sim to AMP 2-330808-8.
XY3	19A700042P3	Contact, electrical: sim to AMP 2-332070-2.
XY4 and XY5	19A115834P1	Contact, electrical: sim to AMP 2-330808-8.
		- - - - - - - - - - FILTERS - - - - - - - - - -
Z1	19A702522G11	Crystal pair. (Includes Z2).
Z2		(Part of Z1).
Z3	19A702171P1	Bandpass filter: 455 ±1.5 kHz; sim to Murata CFU455D2.
		- - - - - - - - - MISCELLANEOUS - - - - - - - - -
	19A702471P2	Crystal pad. (Used in Z1 & Z2).
	19A134793P1805	Screw, thread forming: No. 1-64 x 7/32. (Secures J1 mounting).
	19A702945P1	Shield.
	19D900639G2	Battery Pack. 7.5 Volt.
	19D900639G3	Battery Pack. 10 Volt.
		ASSOCIATED PARTS
		- - - - - - - - - - CRYSTALS - - - - - - - - - -
		NOTE: when reordering specify GE part number and exact frequency needed.
		$Fx = \frac{Fo - 21.4}{9}$
Y1 and Y2	19A702375G2	Quartz.
		$Fx = \frac{Fo}{8}$
Y3	19A702284G3	Quartz: 20945.000 kHz
	19A702284G4	(Alternate IF Crystal) 21855.0 kHz.
Y4 and Y5	19A702375G1	Quartz.
		- - - - - - - - - - MISCELLANEOUS - - - - - - - - - -
	19B800886P3	Whip antenna. (403-470 MHz).
	19B800886P4	Whip antenna. (470-494 MHz).
	19B800886P5	Whip antenna. (489-512 MHz).

PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a Revision Letter which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for the descriptions of parts affected by these revisions.

REV. A - TRANSMITTER/RECEIVER BOARD 19D901656G1-5
To improve transmitter operation at less than 7.5 volts, changed R48 from 100 ohms (19B800607P101) to 39 ohms (19B800607P390).

REV. B - TRANSMITTER/RECEIVER BOARD 19D901656G1-5
To facilitate manufacturing, changed interconnect pins from solder mount to stake mount.

REV. C - TRANSMITTER/RECEIVER BOARD 19D901656G1-4
REV. A - TRANSMITTER/RECEIVER BOARD 19D901656G13-16
To prevent RF Amp from oscillating while tuning C4 and C9, changed R4 from 3.3K (19A800607P332) to 2.7K (19A800607P272). To facilitate manufacturing, changed C86 (G4 and G16 only) from 24 pF (19A702061P31) to 33 pF (19A702061P37). Also changed Q10 (G3 and G15 only) from 19A701940P3 to 19A701940P4.

REV. D - TRANSMITTER/RECEIVER BOARD 19D901656G1-4
REV. C - TRANSMITTER/RECEIVER BOARD 19D901656G5
REV. B - TRANSMITTER/RECEIVER BOARD 19D901656G13-16
REV. A - TRANSMITTER/RECEIVER BOARD 19D901656G17
Changed WT1-WT12 electrical contacts (12 places) from 19A702752P2 to 19A701329P1.

REV. E - TRANSMITTER/RECEIVER BOARD 19D901656G3
REV. C - TRANSMITTER/RECEIVER BOARD 19D901656G15
To improve transmitter output power and reduce output PA transistors operating temperature, changed C65 from 15 pF (19A702236P30) to 6.8 pF (19A702236P21). To improve SINAD, changed C8 from .5 pF (19A702236P1) to .7 pF (19A702236P3).

REV. E - TRANSMITTER/RECEIVER BOARD 19D901656G2
REV. C - TRANSMITTER/RECEIVER BOARD 19D901656G14
To improve high-end receiver tuning, changed L9 from 680 nH (19A700024P11) to 390 nH (19A700024P8).

REV. B - TRANSMITTER/RECEIVER BOARD 19D901656G17
REV. C - TRANSMITTER/RECEIVER BOARD 19D901656G13, G16
REV. D - TRANSMITTER/RECEIVER BOARD 19D901656G14, G15
To improve transmitter reliability, changed D1 on the Low-pass Filter Board from 19A702411P1 to 19J706892P2.

PARTS LIST

FRONT COVER
19D900647G1 STANDARD
19D900647G2 LICENSEE
19D900647G4 CGE OPTION
ISSUE 5

SYMBOL	GE PART NO.	DESCRIPTION
		- - - - - - - - SPEAKERS AND MIKES - - - - - - - -
B1	19A134460P1	Loudspeaker, permanent magnet: 2 inches, 8 ohms + or - 10%,imp 500 mW, 450 + or -100 Hz resonant freq; sim to Pioneer A50AP13-01F.
B2	19J706041P1	Microphone cartridge: 200-850 ohms output imp., 1.5 to 10 VDC; sim to Primo EM-60.
		- - - - - - - - - - CAPACITORS - - - - - - - - - -
C1 and C2	19A700232P64	Ceramic: 100 pF + or -10%, 100 VDCW, temp coef -5600 PPM.
C3	19B800650P13	Tantalum: 1 uF -20+40%, 10 VDCW.
		- - - - - - - - - - - PLUGS - - - - - - - - - - -
P4		Connector. Includes:
	19A702405P4	Shell.
	19A702405P28	Contact, electrical.
W1	19B800860G1	Cable assembly. (Includes P4)
		- - - - - - - - - MISCELLANEOUS - - - - - - - - -
	19A702396P1	Nameplate. (GENERAL ELECTRIC).
	19C850975P1	Insulator.
	19A703346P1	Pad.
	19A149342P3	Pad.

PARTS LIST

HARDWARE KIT
19A702379G1 SINGLE/MULTI FREQ
19A702379G2 UHF
19A702379G3 HIGH BAND
ISSUE 5

SYMBOL	GE PART NO.	DESCRIPTION
	19A702471P3	Crystal pad. (Used with Y3).
	19A702471P2	Crystal pad. (Used with Y1, Y2, Y4, Y5).
	19A702332P1	Nut, slotted: M7 x .75. (Secures R32 & S1).
	19B800849P1	Washer, rectangular. (Located between ON-OFF switch and housing).
	19A702314P2	Knurled nut. (Secures J11).
	19A703007P212	Machine screw, Torx drive: M2.5-.45 x 12. (Secures rear cover below nameplates).
	19A702362P208	Machine screw, Torx drive: M2.5-.45 x 8. (Secures rear cover at top).
	19B800859P1	Knob, push on.
	19A702364P104	Machine screw, Torx®Drive: M2-0.4 x 4. (Secures option cover).
	19A700032P1	Lockwasher, internal tooth: No. 2. (Secures option cover).
	19D900667P1	Option Cover.
	N248P15B	Hex nut.

PARTS LIST

AUDIO BOARD

19D901123G1 STANDARD
19D901123G2 DTMF
19D901123G7 STANDARD (GOLD CONTACTS)
19D901123G7 DTMF (GOLD CONTACTS)

ISSUE 2

SYMBOL	GE PART NO.	DESCRIPTION
		NOTE: WHEN REPLACING BOARDS, CARE SHOULD BE TAKEN TO ASSURE THAT BOARDS WITH GOLD CONTACTS ARE NOT INTERMIXED WITH BOARDS HAVING TIN CONTACTS. REPLACE THE BOARD ONLY WITH ONE HAVING THE SAME GROUP NUMBER AS THE ORIGINAL.
		- - - - - - - - - - CAPACITORS - - - - - - - - - -
C1	19A702052P120	Ceramic: 0.033 uF ±5%, 50 VDCW.
C2 and C3	19A702052P112	Ceramic: 6800 pF ±5%, 50 VDCW.
C4	19A702052P128	Ceramic: 0.022 uF ±5%, 50 VDCW.
C5	19A702052P12	Ceramic: 6800 pF ±10%, 50 VDCW.
C6	19A702844P1	Tantalum: 22 uF ±20%, 6.3 VDCW.
C7 - C8	19A702052P10	Ceramic: 4700 pF ±10%, 50 VDCW.
	19A702052P4	Ceramic: 680 pF ±10%, 50 VDCW.
C9	19A702052P26	Ceramic: 0.1 uF ±10%, 50 VDCW.
C10	19B800755P7	Electrolytic: 100 uF ±20%, 10 VDCW.
C11	19B800755P4	Electrolytic: 10 uF ±20%, 16 VDCW.
C12 and C13	19A702052P26	Ceramic: 0.1 uF ±10%, 50 VDCW.
C14	19A703324P1	Electrolytic: 22 uF ±20%, 16 VDCW.
C15	19A702052P107	Ceramic: 2200 pF ±5%, 50 VDCW.
C16	19A701534P4	Tantalum: 1 uF ±20%, 35 VDCW.
C17	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C18	19A702052P5	Ceramic: 1000 pF ±10%, 50 VDCW.
C19	19B800755P4	Electrolytic: 10 uF ±20%, 16 VDCW.
C20	19A702052P122	Ceramic: 0.047 uF ±5%, 50 VDCW.
C21	19A702052P110	Ceramic: 4700 pF ±5%, 50 VDCW.
C22 and C23	19A702052P122	Ceramic: 0.047 uF ±5%, 50 VDCW.
C24	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G2 and G8).
C25	19A702052P106	Ceramic: 1500 pF ±5%, 50 VDCW.
C26	19B800755P2	Electrolytic: 2.2 uF ±20%, 50 VDCW.
C27	19A702061P77	Ceramic: 470 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM. (Used in G2 and G8).
C28	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C30 and C31	19B800755P2	Electrolytic: 2.2 uF ±20%, 50 VDCW.
C32	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
C33	19A702052P26	Ceramic: 0.1 uF ±10%, 50 VDCW.
C37 *	19A702061P61	Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM.
		- - - - - - - - - - - DIODES - - - - - - - - - - -
D1 and D2	19A700028P1	Silicon: 75 mA, 75 PIV; sim to 1N4148.
		- - - - - - - - - - - PLUGS - - - - - - - - - - -
P2 and P3	19A700041P56	Printed wire: 7 contacts rated @ 2.5 amps; sim to Molex 22-02-2075. (Used in G1 and G2).
P2 and P3	19A704779P56	Printed wire: 7 contacts rated @ 2.5 amps. (Used in G7 and G8).

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

SYMBOL	GE PART NO.	DESCRIPTION
R44	19B800607P102	Metal film: 1K ohms ±5%, 1/8 w.
R45	19B800607P471	Metal film: 470 ohms ±5%, 1/8 w.
		- - - - - - - - - INTEGRATED CIRCUITS - - - - - - - -
U1	19A702410P1	Linear: Audio Amplifier; sim to TBA-820M.
		- - - - - - - - - - MISCELLANEOUS - - - - - - - - - -
	19A701622P1	Cotter pin. (Between R15 and R19; Used in G2 and G8).
	19A149342P2	Pad.
	19A149342P1	Pad.

PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for the descriptions of parts affected by these revisions.

REV. A - AUDIO BOARD 19D901123G1, G2
REV. B - AUDIO BOARD 19D901123G1, G2
To improve manufacturing process, reduced the size of the printed wire board pads for the chip componets by approximately 50%.

REV. C - AUDIO BOARD 19D901123G1, G2
To improve deviation symmetry and modulation balance for CG input, changed R30 from 330K (19B800607P334) to 270K (19B800607P274) and R42 from 47K (19B800607P473) to 22K (19B800607P223).

REV. D - AUDIO BOARD 19D901123G1, G2
REV. E - AUDIO BOARD 19D901123G1, G2
REV. A - AUDIO BOARD 19D901123G7, G8
To improve receiver audio muting during transmissions, added C37. Also added holes to board for use with radio data link.

REV. B - AUDIO BOARD 19D901123G8 (FOR CANADIAN GE ONLY)
To prevent transmitter audio squeal, added C201, C202 and C203. (See Modification Kit 19A703929G1).

SYMBOL	GE PART NO.	DESCRIPTION
		- - - - - - - - - - TRANSISTORS - - - - - - - - - -
Q1	19A134739P2	Silicon, NPN.
Q2	19A700026P1	Silicon, PNP.
Q3 and Q4	19A700076P2	Silicon, NPN: sim to MMBT3904, low profile.
Q5	19A700076P2	Silicon, NPN: sim to MMBT3904, low profile. (Used in G2 and G8).
Q6 and Q7	19A700076P2	Silicon, NPN: sim to MMBT3904, low profile.
Q8	19A700059P2	Silicon, PNP.
Q9	19A700076P2	Silicon, NPN: sim to MMBT3904, low profile.
Q10	19A702760P1	Silicon, FET: P channel.
		- - - - - - - - - - RESISTORS - - - - - - - - - -
R1	19B800607P333	Metal film: 33K ohms ±5%, 1/8 w.
R2	19B800607P683	Metal film: 68K ohms ±5%, 1/8 w.
R3	19B800607P393	Metal film: 39K ohms ±5%, 1/8 w.
R4	19B800607P333	Metal film: 33K ohms ±5%, 1/8 w.
R5 and R6	19B800607P473	Metal film: 47K ohms ±5%, 1/8 w.
R7	19B800607P153	Metal film: 15K ohms ±5%, 1/8 w.
R8	19B800607P821	Metal film: 820 ohms ±5%, 1/8 w.
R9	19B800607P153	Metal film: 15K ohms ±5%, 1/8 w.
R10	19B800607P180	Metal film: 18 ohms ±5%, 1/8 w.
R11	19B800607P104	Metal film: 100K ohms ±5%, 1/8 w.
R13	19A702289P1	Metal film: 1 ohms ±5%, 1/4 w; sim to Corning FL55.
R14	19B800607P471	Metal film: 470 ohms ±5%, 1/8 w.
R15	19B800607P472	Metal film: 4.7K ohms ±5%, 1/8 w.
R16	19B800607P183	Metal film: 18K ohms ±5%, 1/8 w.
R17	19B800607P683	Metal film: 68K ohms ±5%, 1/8 w.
R18	19B800607P473	Metal film: 47K ohms ±5%, 1/8 w.
R19	19B800607P562	Metal film: 5.6K ohms ±5%, 1/8 w.
R20	19B800607P183	Metal film: 18K ohms ±5%, 1/8 w.
R21	19B800607P472	Metal film: 4.7K ohms ±5%, 1/8 w.
R22	19B800607P331	Metal film: 330 ohms ±5%, 1/8 w.
R23	19B800607P821	Metal film: 820 ohms ±5%, 1/8 w.
R24	19B800607P104	Metal film: 100K ohms ±5%, 1/8 w.
R25	19B800607P473	Metal film: 47K ohms ±5%, 1/8 w.
R26	19B800607P823	Metal film: 82K ohms ±5%, 1/8 w.
R27	19B800607P473	Metal film: 47K ohms ±5%, 1/8 w. (Used in G2 and G8).
R28	19B800607P224	Metal film: 220K ohms ±5%, 1/8 w.
R29	19B800607P823	Metal film: 82K ohms ±5%, 1/8 w.
R30 *	19B800607P274	Metal film: 270K ohms ±5%, 1/8 w.
R31	19B800607P103	Metal film: 10K ohms ±5%, 1/8 w.
R32	19B800607P223	Metal film: 22K ohms ±5%, 1/8 w.
R33	19B800607P183	Metal film: 18K ohms ±5%, 1/8 w.
R34	19B800607P333	Metal film: 33K ohms ±5%, 1/8 w.
R35	19B800607P103	Metal film: 10K ohms ±5%, 1/8 w.
R36	19B800607P223	Metal film: 22K ohms ±5%, 1/8 w.
R37	19B800607P183	Metal film: 18K ohms ±5%, 1/8 w.
R38	19A701828P1	Thermistor: 3.3K ohms ±5%; sim to Philips 2322-642-63332/
R39	19B800607P124	Metal film: 120K ohms ±5%, 1/8 w.
R40	19B800607P273	Metal film: 27K ohms ±5%, 1/8 w.
R41	19B800607P224	Metal film: 220K ohms ±5%, 1/8 w. (Used in G2 and G8).
R42 *	19B800607P223	Metal film: 22K ohms ±5%, 1/8 w.
R43	19B800607P473	Metal film: 47K ohms ±5%, 1/8 w. (Used in G2 and G8).

PARTS LIST

SIDE PANEL
19D900646G1 SINGLE FREQUENCY
19D900646G3 TWO FREQUENCY
ISSUE 4

C4

SYMBOL	GE PART NO.	DESCRIPTION
		- - - - - - - - - - - - SWITCHES - - - - - - - - - -
S1	19B800847P1	Push-button: contacts rated 25 mA @ 9 VDC; sim to Bowmar KB3256-1D.
		- - - - - - - - - - MISCELLANEOUS - - - - - - - - - -
	19D900575P1	Side Panel.
	19A702461P1	Screw, thread forming.
	19B800864G1	Pushbutton.
	19C850854P1	Slide button.
	19A702459P1	Tape.
	19A702460P1	Contact, electrical. (Quantity 2).
	19A702471P6	Crystal Pad.
	19A703672G1	Switch Stop. (Used in G1).

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

PARTS LIST

REAR COVER
19D901087G1 HB HIGH POWER
19D901087G2 UHF HIGH POWER
19D901087G3 HB LOW POWER
19D901087G4 UHF LOW POWER
ISSUE 1

SYMBOL	GE PART NO.	DESCRIPTION
		- - - - - - - - - - - - PLUGS - - - - - - - - - -
P1		Connector. Includes:
	19B800852P1	Contact, electrical.
	19A701728P2	Washer, non-metallic.
	19A701488P2	Retaining ring.
	19B216401P5	Spring.
	19B800851P1	Insulator.
P2		Connector. Includes:
	19B800852P1	Contact, electrical.
	19A701728P2	Washer, non-metallic;
	19A701488P2	Retaining ring.
	19B216401P5	Spring.
P3 and P4	19A702405P26	Contact, electrical: rated @ 3 amps.
		- - - - - - - - - - MISCELLANEOUS - - - - - - - - - -
	19C850865P1	Option receptacle.
	N327P9008E	Rivet, tubular.
	19A702471P6	Foam pad.
	19C850861P2	Insulator, glass epoxy

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

PARTS LIST

SIDE PANEL
19D901089G1 1 FREQ
19D901089G2 2 FREQ
ISSUE 2

C-5

SYMBOL	GE PART NO.	DESCRIPTION
		- - - - - - - - - - - - JACKS - - - - - - - - - - -
J1 and J2	19A703304P1	Telephone jack: rated 1/8 amp @ 125 VAC; sim to Switchcraft MDSL-280.
		- - - - - - - - - - SWITCHES - - - - - - - - - -
S1	19B800847P1	Push switch: contacts rated 25 mA @ 9 VDC; sim to Bowmar KB3256-1D.
		- - - - - - - - - - MISCELLANEOUS - - - - - - - - - -
	19A702461P1	Screw, thread forming: No. 0-40 x 1/4. (Secures slide button).
	19B800864G1	Pushbutton.
	19C850854P1	Slide button.
	19A702460P1	Contact, electrical. (Used with S1).
	19B232415P1	Bushing.
	19A703672P1	Switch stop.
	19A702471P6	Crystal pad.

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

This addendum covers revision letter changes made on Audio Board 19D901123G7 and G8 and provides signal callouts on Schematic Diagram 19D901659, sheet 2.

REV. B - **AUDIO BOARD 19D901123G7**
REV. C - **AUDIO BOARD 19D901123G8**

To improve stability caused by U1 variations, R46 was added between C12 and U1-2. Also the leads of R13 were lengthened by 1/4 inch to suppress U1 oscillation.

Resistor R46 is 19A702585P47; Composition, 220 ohms ±5%, 1/8 w.

On solder side of board, cut printed run between C12 chip capacitor and the via hole feeding up to U1 pin 2. Add R46 between C12 and the via hole.

Preform leads on R13 to allow an extra 1/4 inch length on each lead to provide lead inductance.

SOLDER SIDE

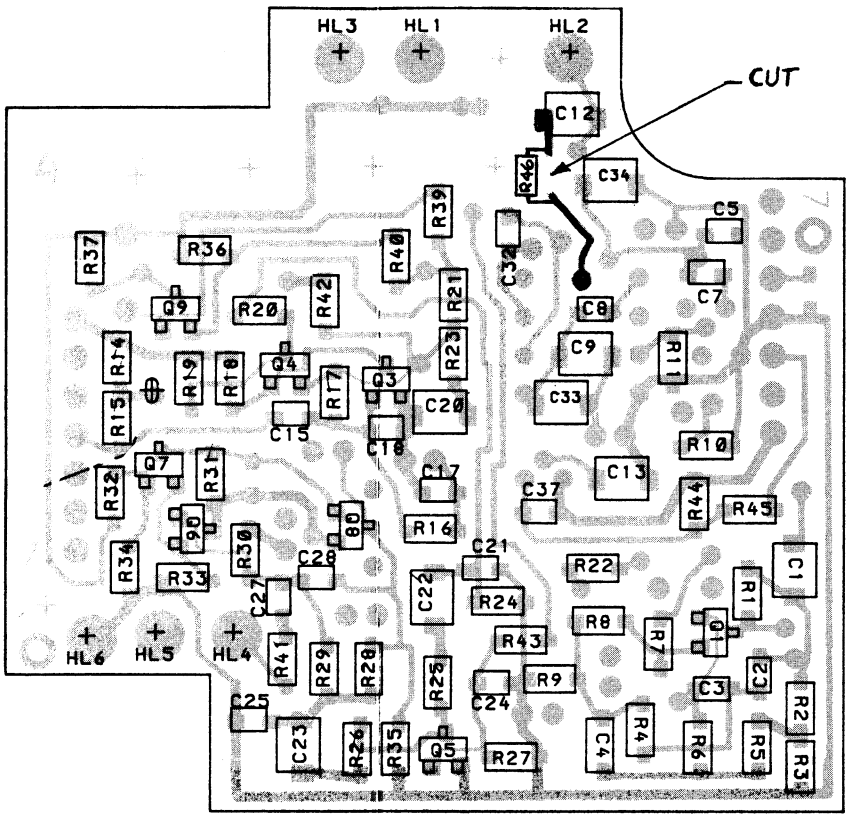


Figure 1 - Location of R46

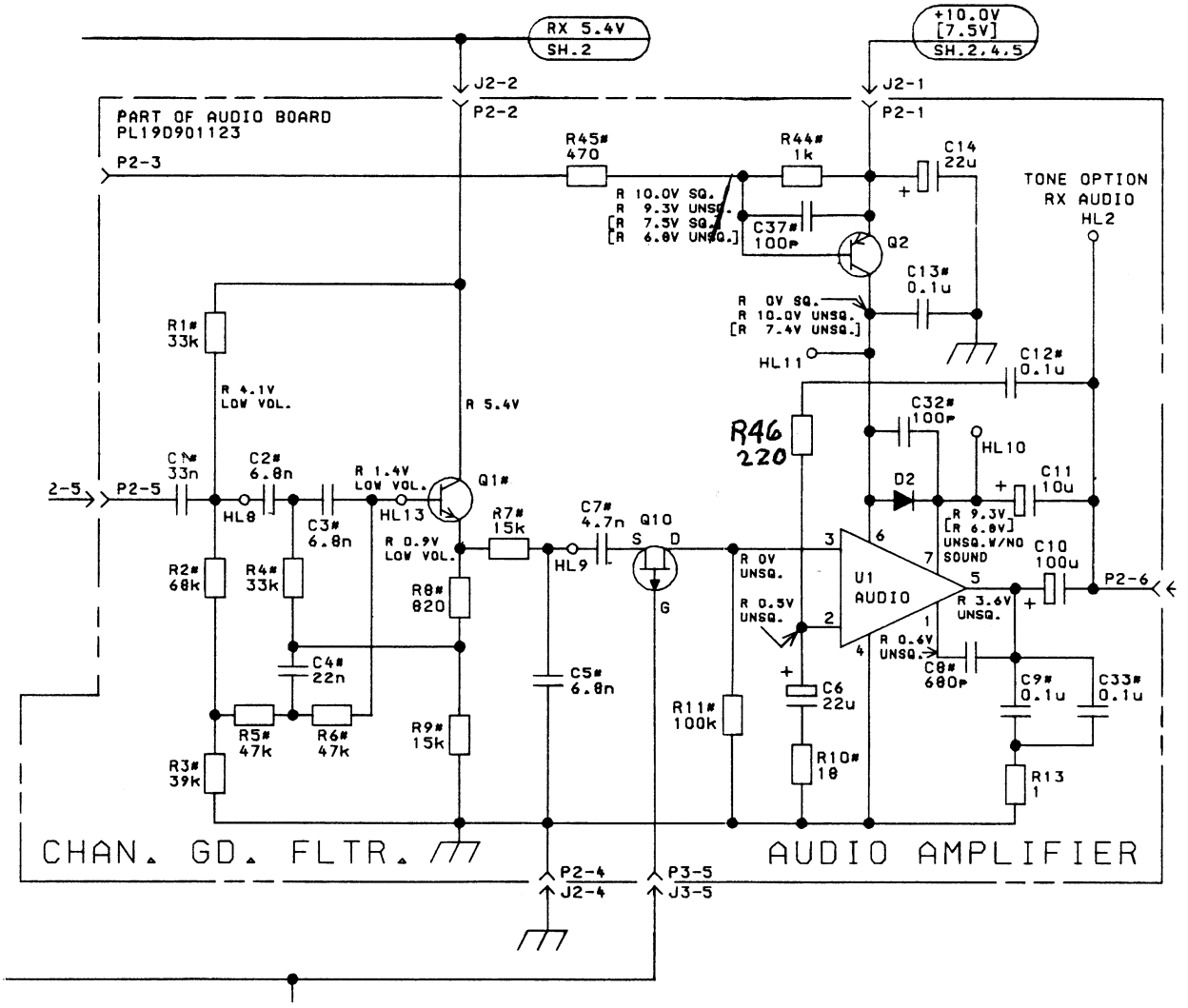
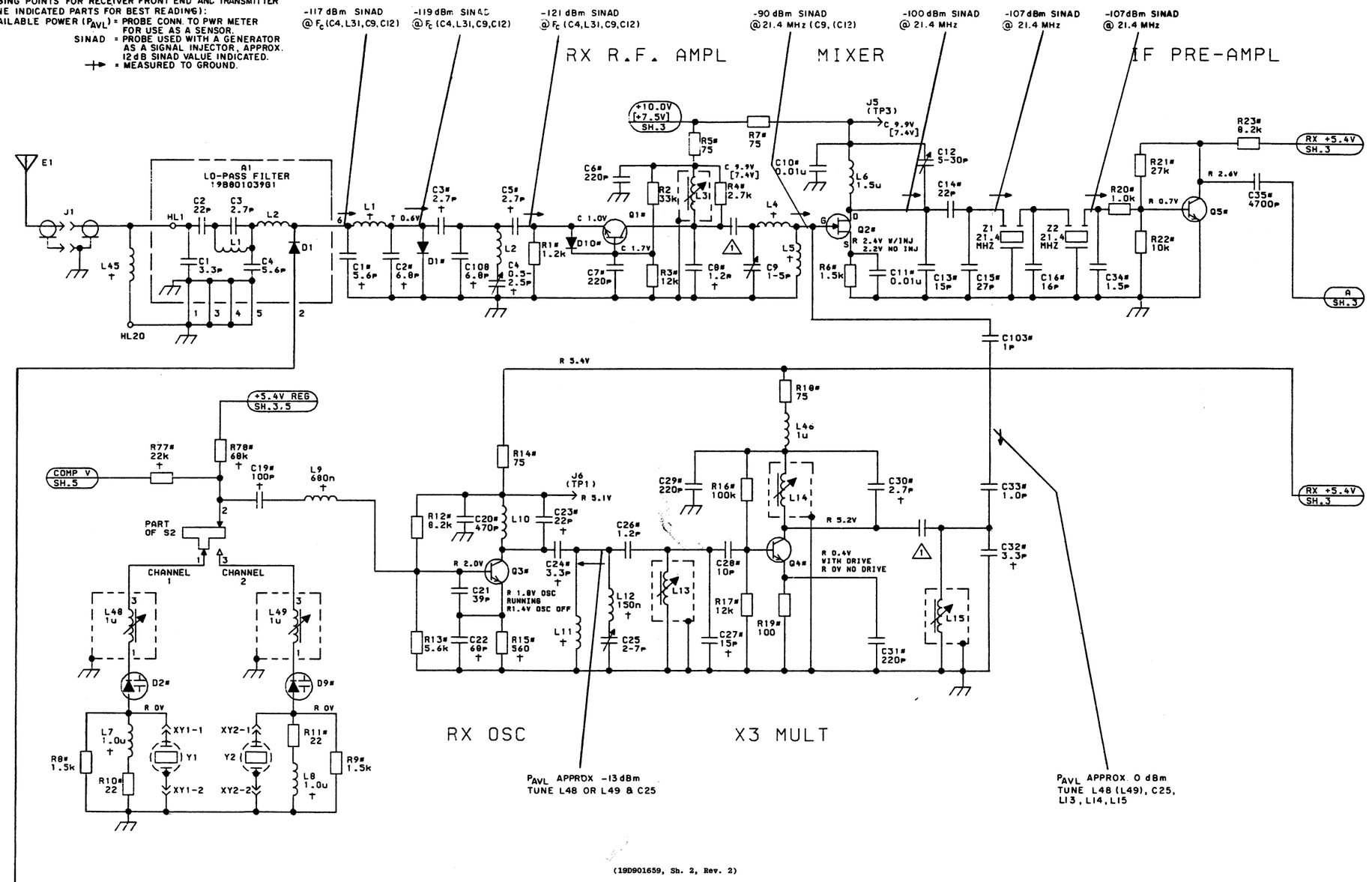


Figure 2 - Partial Schematic Showing R46

LBI-31496

PROBING POINTS FOR RECEIVER FRONT END AND TRANSMITTER (TUNE INDICATED PARTS FOR BEST READING):
AVAILABLE POWER (P_{AVL}) = PROBE CONN. TO PWR METER FOR USE AS A SENSOR.
SINAD = PROBE USED WITH A GENERATOR AS A SIGNAL INJECTOR, APPROX. 12dB SINAD VALUE INDICATED.
⊣+ = MEASURED TO GROUND.



(19D901659, Sh. 2, Rev. 2)

RC4427 SH.2

SCHEMATIC DIAGRAM

403-512 MHz RX
Sheet 2
16